

DATASHEET

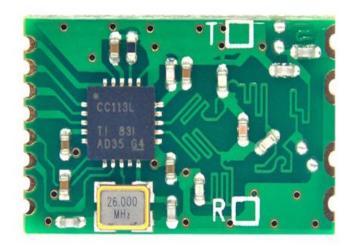
GENERAL DESCRIPTION

The HC210M-R is a cost optimized sub-1 GHz RF receiver for the 300-348 MHz, 387-464 MHz, and 779-928 MHz frequency bands. The circuit is based on the popular CC1101 RF transceiver, and RF performance characteristics are identical. The HC210M-T transmitter together with the HC210M-R receiverenable a low-cost RF link.

The RF receiver is integrated with a highly configurable baseband demodulator. The modem supports various modulation formats and has a configurable data rate up to 600 kbps.

The HC210M-R provides extensive hardware support for packet handling, data buffering, and burst transmissions.

The main operating parameters and the 64-byte receive FIFO of HC210M-R can be controlled through a serial peripheral interface (SPI). In a typical system, the HC210M-R will be used together with a microcontroller and a few additional passive components.



APPLICATIONS

- Ultra low-power wireless applications operating in the 315/433/868/915 MHz ISM/SRD bands
- Wireless Alarm and Security Systems
- **Industrial Monitoring and Control**
- Remote Controls
- Toys
- Home and building automation

KEY PRODUCT FEATURES

RF Performance

Receive Sensitivity Down to -116 dBm at 0.6 kbps Programmable Data Rate from 0.6 to 600 kbps Frequency Bands: 300-348 MHz, 387-464 MHz, and 779-928 MHz

2-FSK, 4-FSK, GFSK, MSK, and OOK Supported **Digital Features**

Flexible Support for Packet Oriented Systems On-chip Support for Sync Word Detection, Flexible Packet Length, and Automatic CRC Calculation

Low-Power Features

200-nA Sleep Mode Current Consumption Fast Startup Time; 240 µ s From Sleep to RX Mode 64-Byte RX FIFO

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Abbreviations

Abbreviations used in this data sheet are described below.

2-FSK	Binary Frequency Shift Keying	LSB	Least Significant Bit
4-FSK	Quaternary Frequency Shift Keying	MCU	Microcontroller Unit
ADC	Analog to Digital Converter	MSB	Most Significant Bit
AFC	Automatic Frequency Compensation	N/A	Not Applicable
AGC	Automatic Gain Control	NRZ	Non Return to Zero (Coding)
AMR	Automatic Meter Reading	OOK	On-Off Keying
BER	Bit Error Rate	PCB	Printed Circuit Board
BT	Bandwidth-Time product	PD	Power Down
CFR	Code of Federal Regulations	PER	Packet Error Rate
CRC	Cyclic Redundancy Check	PLL	Phase Locked Loop
CS	Carrier Sense	POR	Power-On Reset
DC	Direct Current	PTAT	Proportional To Absolute Temperature
DVGA	Digital Variable Gain Amplifier	QLP	Quad Leadless Package
ESR	Equivalent Series Resistance	QPSK	Quadrature Phase Shift Keying
FCC	Federal Communications Commission	RC	Resistor-Capacitor
FIFO	First-In-First-Out	RF	Radio Frequency
FS	Frequency Synthesizer	RSSI	Received Signal Strength Indicator
GFSK	Gaussian shaped Frequency Shift Keying	RX	Receive, Receive Mode
IF	Intermediate Frequency	SMD	Surface Mount Device
I/Q	In-Phase/Quadrature	SPI	Serial Peripheral Interface
ISM	Industrial, Scientific, Medical	SRD	Short Range Devices
LC	Inductor-Capacitor	VCO	Voltage Controlled Oscillator
LNA	Low Noise Amplifier	XOSC	Crystal Oscillator
LO	Local Oscillator	XTAL	Crystal

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1 Absolute Maximum Ratings

Under no circumstances must the absolute maximum ratings given in Table 1 be violated. Stress exceeding one or more of the limiting values may cause permanent damage to the device.

Table 1: Absolute Maximum Ratings

Parameter	Min	Max	Units	Condition
Supply voltage	-0.3	3.9	V	All supply pins must have the same voltage
Voltage on any digital pin	-0.3	VDD + 0.3, max 3.9	V	
Voltage on the pins RF_P, RF_N, DCOUPL, RBIAS	-0.3	2.0	>	
Voltage ramp-up rate		120	kV/μs	
Input RF level		+10	dBm	
Storage temperature range	-50	150	$^{\circ}$	
Solder reflow temperature		260	$^{\circ}$	According to IPC/JEDEC J-STD-020
ESD		750	٧	According to JEDEC STD 22, method A114, Human Body Model (HBM)
ESD		400	V	According to JEDEC STD 22, C101C, Charged Device Model (CDM)



Caution! ESD sensitive device. Precaution should be used when handling the device in order to prevent permanent damage.

2 Operating Conditions

The operating conditions for **#C210M-R** are listed in Table 2 below.

Table 2: Operating Conditions

Parameter	Min	Max	Unit	Condition
Operating temperature	-40	85	$^{\circ}$	
Operating supply voltage	1.8	3.6	V	All supply pins must have the same voltage

3 General Characteristics

Table 3: General Characteristics

Parameter	Min	Max	Unit	Condition/Note		
	300	348	MHz			
Frequency range	387	464	MHz	If using a 27 MHz crystal, the lower frequency limit for this band is 392 MHz		
	779	928	MHz			
	0.6	500	kBaud	2-FSK		
	0.6	250	kBaud	GFSK and OOK		
Data rate		300	kBaud	4-FSK (the data rate in kbps will be twice the baud rate)		
	0.6			Optional Manchester encoding (the data rate in kbps will the baud rate)		

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4 Electrical Specifications

4.1 Current Consumption

 $T_A = 25$ °C , VDD = 3.0 V if nothing else stated. All measurement results are obtained using [1] and [2]. Reduced current settings (MDMCFG2.DEM_DCFILT_OFF=1) gives a slightly lower current consumption at the cost of a reduction in sensitivity. See Table 5 for additional details on current consumption and sensitivity.

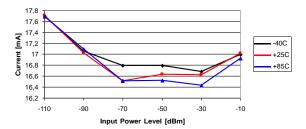
Table 4: Current Consumption

Parameter	Min	Тур	Max	Unit	Condition
Current onsumption in		0.2	1	μА	Voltage regulator to digital part off, register values retained (SLEEP state). All GDO pins programmed to 0x2F (HW to 0)
power down modes		100		μА	Voltage regulator to digital part off, register values retained, XOSC running (SLEEP state with MCSM0.OSC_FORCE_ON
		165		μА	Voltage regulator to digital part on, all other modules in power down (XOFF state)
Current consumption		1.7		mA	Only voltage regulator to digital part and crystal oscillator running (IDLE state)
		8.4		mA	The current consumption for the intermediate states when going from IDLE to RX, including the calibration state
Current consumption,		15.4		mA	Receive mode, 1.2 kBaud, reduced current, input at sensitivity limit
315 MHz		14.4		mA	Receive mode, 1.2 kBaud, register settings optimized for reduced current, input well above sensitivity limit
		15.2		mA	Receive mode, 38.4 kBaud, register settings optimized for reduced current, input at sensitivity limit
		14.3		mA	Receive mode, 38.4 kBaud, register settings optimized for reduced current, input well above sensitivity limit
		16.5		mA	Receive mode, 250 kBaud, register settings optimized for reduced current, input at sensitivity limit
		15.1		mA	Receive mode, 250 kBaud, register settings optimized for reduced current, input well above sensitivity limit
Current consumption,		16.0		mA	Receive mode, 1.2 kBaud, register settings optimized for reduced current, input at sensitivity limit
433 MHz		15.0		mA	Receive mode, 1.2 kBaud, register settings optimized for reduced current, input well above sensitivity limit
		15.7		mA	Receive mode, 38.4 kBaud, register settings optimized for reduced current, input at sensitivity limit
		15.0		mA	Receive mode, 38.4 kBaud, register settings optimized for reduced current, input well above sensitivity limit
		17.1		mA	Receive mode, 250 kBaud, register settings optimized for reduced current, input at sensitivity limit
		15.7		mA	Receive mode, 250 kBaud, register settings optimized for reduced current, input well above sensitivity limit

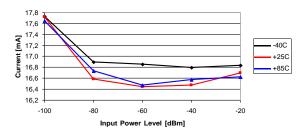
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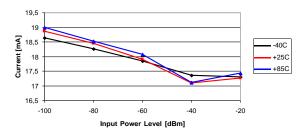
Parameter	Min	Тур	Ma	Uni	Condition				
Current consumption, 868/915 MHz		15.7		mA	Receive mode, 1.2 kBaud, register settings optimized for reduced current, input at sensitivity limit. See Figure 1 for current consumption with register settings optimized for sensitivity.				
		14.7		mA	Receive mode, 1.2 kBaud, register settings optimized for reduced current, input well above sensitivity limit. See Figure 1 for current consumption with register settings optimized for sensitivity.				
		15.6		mA	Receive mode, 38.4 kBaud, register settings optimized for reduced current, input at sensitivity limit. See Figure 1 for current consumption with register settings optimized for sensitivity.				
		14.6		mA	Receive mode, 38.4 kBaud, register settings optimized for reduced current, input well above sensitivity limit. See Figure 1 for current consumption with register settings optimized for				
	16.9 mA				Receive mode, 250 kBaud, register settings optimized for reduced current, input at sensitivity limit. See Figure 1 for current consumption with register settings optimized for sensitivity.				
		15.6		mA	Receive mode, 250 kBaud, register settings optimized for reduced current, input well above sensitivity limit. See Figure 1 for current consumption with register settings optimized for sensitivity.				



1.2 kBaud GFSK



38.4 kBaud GFSK



250 kBaud GFSK

Figure 1: Typical RX Current Consumption over Temperature and Input Power Level, 868/915 MHz, Sensitivity Optimized Setting

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4.2 RF Receive Section

Table 5: RF Receive Section

Parameter	Min	Тур	Max	Unit	Condition/Note						
Digital channel filter bandwidth	58		812	kHz	User programmable. The bandwidth limits are proportional to crystal frequency (given values assume a 26.0 MHz crystal)						
Spurious emissions		-68	–57	dBm	25 MHz - 1 GHz (Maximum figure is the ETSI EN 300 220 V2.3.1 limit)						
		-66	-47	dBm	Above 1 GHz (Maximum figure is the ETSI EN 300 220 V2.3.1 limit)						
					Typical radiated spurious emission is -49 dBm measured at the VCO frequency						
RX latency		9		bit	Serial operation. Time from start of reception until data is available on the receiver data output pin is equal to 9 bit						
315 MHz											
1.2 kBaud data r (2-FSK, 1% packe	ate, ser et error	n sitivity o rate, 20 b	ptimize ytes pad	ed, MDMC cket leng	CFG2.DEM_DCFILT_OFF=0 pth, 5.2 kHz deviation, 58 kHz digital channel filter bandwidth)						
Receiver sensitivity		–111		dBm	Sensitivity can be traded for current consumption by setting MDMCFG2.DEM_DCFILT_OFF=1. The typical current consumption is then reduced from 17.2 mA to 15.4 mA at the sensitivity limit. The sensitivity is typically reduced to -109 dBm						
433 MHz											
0.6 kBaud data r (GFSK, 1% packe	ate, ser	n sitivity o rate, 20 by	ptimize /tes pac	ed, MDMC ket leng	CFG2.DEM DCFILT_OFF=0 pth, 14.3 kHz deviation, 58 kHz digital channel filter bandwidth)						
Receiver sensitivity		-116		dBm							
					CFG2.DEM_DCFILT_OFF=0 th, 5.2 kHz deviation, 58 kHz digital channel filter bandwidth)						
Receiver sensitivity		-112		dBm	Sensitivity can be traded for current consumption by setting MDMCFG2.DEM_DCFILT_OFF=1. The typical current consumption is then reduced from 18.0 mA to 16.0 mA at the sensitivity limit. The sensitivity is typically reduced to -110 dBm						
38.4 kBaud data (GFSK, 1% packe	rate, se	ensitivity rate, 20 by	optimiz /tes pac	zed, MDI ket leng	th, 20 kHz deviation, 100 kHz digital channel filter bandwidth)						
Receiver sensitivity		-104		dBm							
					CFG2 . DEM_DCFILT_OFF=0 pth, 127 kHz deviation, 540 kHz digital channel filter bandwidth)						
Receiver sensitivity		- 95		dBm							

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Parameter	Min	Тур	Max	Unit	Condition/Note							
868/915 MHz												
1.2 kBaud data rate, sen (GFSK, 1% packet error r	sitivity ate, 20	optimize bytes pac	ed, MDM cket len	CFG2 . I gth, 5.2	DEM_DCFILT_OFF=0 kHz deviation, 58 kHz digital channel filter bandwidth)							
Receiver sensitivity		-112		dBm	Sensitivity can be traded for current consumption by setting MDMCFG2.DEM_DCFILT_OFF=1. The typical current consumption is then reduced from 17.7 mA to 15.7 mA at sensitivity limit. The sensitivity is typically reduced to							
Saturation		-14		dBm	FIFOTHR.CLOSE_IN_RX=0. See more in DN010 [5]							
Adjacent channel rejection ±100 kHz offset		37		dB	Desired channel 3 dB above the sensitivity limit. 100 kHz channel spacing See Figure 2 for selectivity performance at other offset frequencies							
Image channel rejection		31		dB	IF frequency 152 kHz							
image charmer rejection		31		uБ	Desired channel 3 dB above the sensitivity limit							
Blocking ±2 MHz offset ±10 MHz offset		-50 -40		dBm dBm	Desired channel 3 dB above the sensitivity limit See Figure 2 for blocking performance at other offset frequencies							
38.4 kBaud data rate, se (GFSK, 1% packet error r	nsitivit ate, 20	y optimiz bytes pad	zed, MD cket len	MCFG2 .gth, 20	DEM_DCFILT_OFF=0 kHz deviation, 100 kHz digital channel filter bandwidth)							
Receiver sensitivity		-104		dBm	Sensitivity can be traded for current consumption by setting MDMCFG2.DEM_DCFILT_OFF=1. The typical current consumption is then reduced from 17.7 mA to 15.6 mA at the sensitivity limit. The sensitivity is typically							
Saturation		-16		dBm	FIFOTHR.CLOSE_IN_RX=0. See more in DN010 [5]							
Adjacent channel -200 kHz offset +200 kHz offset		12 25		dB dB	Desired channel 3 dB above the sensitivity limit. 200 kHz channel spacing See Figure 3 for blocking performance at other offset frequencies							
Image channel rejection		23		dB	IF frequency 152 kHz Desired channel 3 dB above the sensitivity limit							
Blocking ±2 MHz offset ±10 MHz offset		-50 -40		dBm dBm	Desired channel 3 dB above the sensitivity limit See Figure 3 for blocking performance at other offset frequencies							
250 kBaud data rate, ser (GFSK, 1% packet error r					DEM_DCFILT_OFF=0 7 kHz deviation, 540 kHz digital channel filter bandwidth)							
Receiver sensitivity		- 95		dBm	Sensitivity can be traded for current consumption by setting MDMCFG2.DEM_DCFILT_OFF=1. The typical current consumption is then reduced from 18.9 mA to 16.9 mA at the sensitivity limit. The sensitivity is typically							
Saturation		-17		dBm	FIFOTHR.CLOSE_IN_RX=0. See more in DN010 [5]							
Adjacent channel rejection		25		dB	Desired channel 3 dB above the sensitivity limit. 750 kHz channel spacing See Figure 4 for blocking performance at other offset frequencies							
Image channel rejection		14		dB	IF frequency 304 kHz Desired channel 3 dB above the sensitivity limit							
Blocking ±2 MHz offset ±10 MHz offset		-50 -40		dBm dBm	Desired channel 3 dB above the sensitivity limit See Figure 4 for blocking performance at other offset frequencies							



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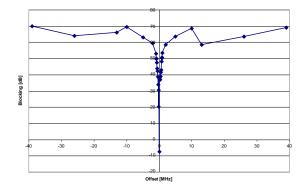
Parameter	Min	Тур	Max	Unit	Condition/Note					
4-FSK, 125 kBaud data rate (250 kbps), sensitivity optimized, MDMCFG2.DEM_DCFILT_OFF=0 (1% packet error rate, 20 bytes packet length, 127 kHz deviation, 406 kHz digital channel filter bandwidth)										
Receiver sensitivity		-96		dBm						
4-FSK, 250 kBaud data (1% packet error rate, 20	4-FSK, 250 kBaud data rate (500 kbps), sensitivity optimized, MDMCFG2.DEM_DCFILT_OFF=0 (1% packet error rate, 20 bytes packet length, 254 kHz deviation, 812 kHz digital channel filter bandwidth									
Receiver sensitivity		- 91		dBm						
4-FSK, 300 kBaud data rate (600 kbps), sensitivity optimized, MDMCFG2.DEM_DCFILT_OFF=0 (1% packet error rate, 20 bytes packet length, 228 kHz deviation, 812 kHz digital channel filter bandwidth)										
Receiver sensitivity		-89		dBm						

Table 6: Typical Sensitivity over Temperature and Supply Voltage, 868 MHz, Sensitivity Optimized Setting

	Supply VDD =	_	e	Supply Voltage			Supply Voltage VDD = 3.6 V		
Temperature [°C]	-40	-40 25 85			25	85	-40	25	85
Sensitivity [dBm] 1.2 kBaud	-113	-112	-110	-113	-112	-110	-113	-112	-110
Sensitivity [dBm] 38.4 kBaud	-105	-105 -104 -102		-105	-104	-102	-105	-104	-102
Sensitivity [dBm] 250 kBaud	-97	-96	-92	-97	-95	-92	-97	-94	-92
Sensitivity [dBm] 500 kBaud	-91	-90	-86	- 91	-90	-86	-91	-90	-86

Table 7: Typical Sensitivity over Temperature and Supply Voltage, 915 MHz, Sensitivity Optimized Setting

	Supply Voltage	VDD		Supply VDD = 3	Voltag 3.0 V	е	Supply VDD = 3	Voltag 3.6 V	е
Temperature [°C]	-40	25	85	-40	25	85	-40	25	85
Sensitivity [dBm] 1.2 kBaud	-113	-112	-110	-113	-112	-110	-113	-112	-110
Sensitivity [dBm] 38.4 kBaud	-105	-104	-102	-104	-104	-102	-105	-104	-102
Sensitivity [dBm] 250 kBaud	-97	-94	-92	-97	-95	-92	-97	-95	-92
Sensitivity [dBm] 500 kBaud	-91	-89	-86	-91	-90	-86	-91	-89	-86



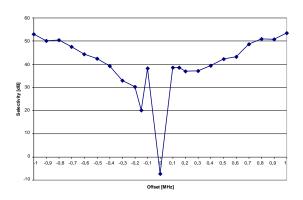
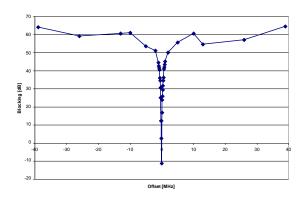


Figure 2: Typical Selectivity at 1.2 kBaud Data Rate, 868.3 MHz, GFSK, 5.2 kHz Deviation. IF Frequency is 152.3 kHz and the Digital Channel Filter Bandwidth is 58 kHz

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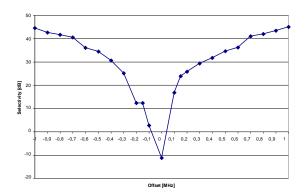
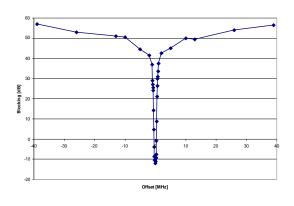


Figure 3: Typical Selectivity at 38.4 kBaud Data Rate, 868 MHz, GFSK, 20 kHz Deviation. IF Frequency is 152.3 kHz and the Digital Channel Filter Bandwidth is 100 kHz



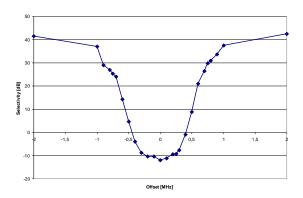
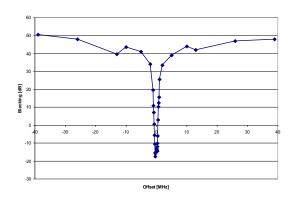


Figure 4: Typical Selectivity at 250 kBaud Data Rate, 868 MHz, GFSK, IF Frequency is 304 kHz and the Digital Channel Filter Bandwidth is 540 kHz



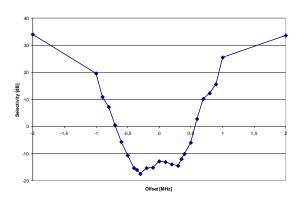


Figure 5: Typical Selectivity at 500 kBaud Data Rate, 868 MHz, GFSK, IF Frequency is 355 kHz and the Digital Channel Filter Bandwidth is 812 kHz

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4.3 Crystal Oscillator

 T_A = 25 $^{\circ}$ C, VDD = 3.0 V if nothing else is stated. All measurement results obtained using [1] and [2].

Table 8: Crystal Oscillator Parameters

Parameter	Min	Тур	Max	Unit	Condition/Note
Crystal frequenc y	26	26	27	MHz	For compliance with modulation bandwidth requirements under EN 300 220 V2.3.1 in the 863 to 870 MHz frequency range it is recommended to use a 26 MHz crystal for frequencies below 869 MHz and a 27 MHz crystal for frequencies above 869 MHz
Tolerance		±40		ppm	This is the total tolerance including a) initial tolerance, b) crystal loading, c) aging, and d) temperature dependence. The acceptable crystal tolerance depends on RF frequency and
Load capacitanc	10	13	20	pF	Simulated over operating conditions
ESR			100	Ω	
Start-up time		150		μs	This parameter is to a large degree crystal dependent. Measured on [1] and [2] using crystal AT-41CD2 from NDK

4.4 Frequency Synthesizer Characteristics

 T_A = 25 $^{\circ}$ C, VDD = 3.0 V if nothing else is stated. All measurement results are obtained using [1] and [2]. Min figures are given—using a 27 MHz crystal. Typ. and max figures are given using a 26 MHz crystal

Table 9: Frequency Synthesizer Parameters

Parameter	Min	Тур	Max	Unit	Condition/Note	
Programmed frequency resolution	397	F _{xosc} /2 ¹⁶	412	Hz	26 - 27 MHz crystal. The resolution (in Hz) is equal for all frequency bands	
Synthesizer frequency tolerance		±40		ppm	Given by crystal used. Required accuracy (including temperature and aging) depends on frequency band and channel bandwidth / spacing	
RF carrier phase noise		-92		dBc/Hz	@ 50 kHz offset from carrier	
RF carrier phase noise		-92		dBc/Hz	@ 100 kHz offset from carrier	
RF carrier phase noise		-92		dBc/Hz	@ 200 kHz offset from carrier	
RF carrier phase noise		-98		dBc/Hz	@ 500 kHz offset from carrier	
RF carrier phase noise		-107		dBc/Hz	@ 1 MHz offset from carrier	
RF carrier phase noise		-113		dBc/Hz	@ 2 MHz offset from carrier	
RF carrier phase noise		-119		dBc/Hz	@ 5 MHz offset from carrier	
RF carrier phase noise		-129		dBc/Hz	@ 10 MHz offset from carrier	
PLL turn-on time (See Table 26)	72	75	75	μs	Time from leaving the IDLE state until arriving in the RX state, when not performing calibration. Crystal oscillator running.	
PLL calibration time (See Table 27)	685	712	724	μs	Calibration can be initiated manually automatically before entering or after leaving RX	

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4.5 DC Characteristics

 $T_A = 25$ C if nothing else stated.

Table 10: DC Characteristics

Digital Inputs/Outputs	Min	Max	Uni	Condition
Logic "0" input voltage	0	0.7	V	
Logic "1" input voltage	VDD – 0.7	VDD	V	
Logic "0" output voltage	0	0.5	V	For up to 4 mA output current
Logic "1" output voltage	VDD - 0.3	VDD	V	For up to 4 mA output current
Logic "0" input current	N/A	– 50	n	Input equals 0 V
Logic "1" input current	N/A	50	n	Input equals VDD

4.6 Power-On Reset

For proper Power-On-Reset functionality the power supply should comply with the requirements in Table 11 below. Otherwise, the chip should be assumed to have unknown state until transmitting an SRES strobe over the SPI interface. See Section 18.1 on page 36 for further details.

Table 11: Power-On Reset Requirements

Parameter	Min	Тур	Max	Unit	Condition/Note
Power-up ramp-up time			5	ms	From 0V until reaching 1.8V
Power off time	1			ms	Minimum time between power-on and power-off

5 Pin Configuration

The **HC210M-R** pin-out is shown in Figure 6 and Table 12. See Section 23 for details on the I/O configuration.

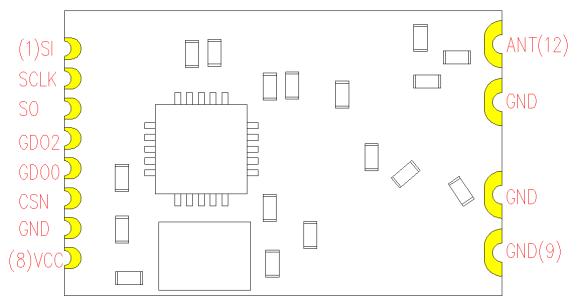


Figure 6: Pinout Top View

Note: The exposed die attach pad **must** be connected to a solid ground plane as this is the main ground connection for the chip

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Table 12: Pinout Overview

Pin#	Pin Name	Pin type	Description
1	SI	Digital Input	SPI Data input.
2	SCLK	Digital Input	Serial configuration interface, clock input
3	SO	Digital Output	Serial configuration interface, data output Optional general output pin when CSn is high
4	GDO02	Digital Output	Digital output pin for general use: • Test signals • FIFO status signals • Clock output, down-divided from XOSC • Serial output RX data
5	GDO0	Digital Output	Digital output pin for general use: • Test signals • FIFO status signals • Clock output, down-divided from XOSC • Serial output RX data
6	SCN	Digital Input	Serial configuration interface, chip select.
7	GND	Ground	Module ground.
8	VCC	Power supply+	1.8-3.6V power supply for module
9,10,11	GND	Ground	Module ground.
12	ANT	Digital Input	Module Antenna terminal, Default terminal

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6 Circuit Description

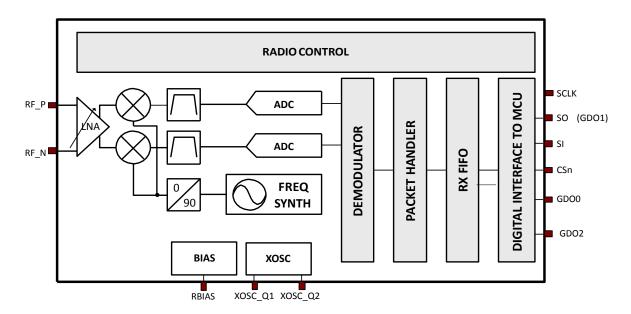


Figure 7: **HC210M-R** Simplified Block Diagram

A simplified block diagram of HC210M-R is shown in Figure 7.

HG210M-R features a low-IF receiver. The received RF signal is amplified by the low-noise amplifier (LNA) and down-converted in quadrature (I and Q) to the intermediate frequency (IF). At IF, the I/Q signals are digitised by the ADCs. Automatic gain control (AGC), fine channel filtering, demodulation, and bit/packet synchronization are performed digitally.

The frequency synthesizer includes a completely on-chip LC VCO and a 90 degree phase shifter for generating the I and Q LO

signals to the down-conversion mixers in receive mode.

A crystal is to be connected to XOSC_Q1 and XOSC_Q2. The crystal oscillator generates the reference frequency for the synthesizer, as well as clocks for the ADC and the digital part.

A 4-wire SPI serial interface is used for configuration and data buffer access.

The digital baseband includes support for channel configuration, packet handling, and data buffering.

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7 Application Circuit

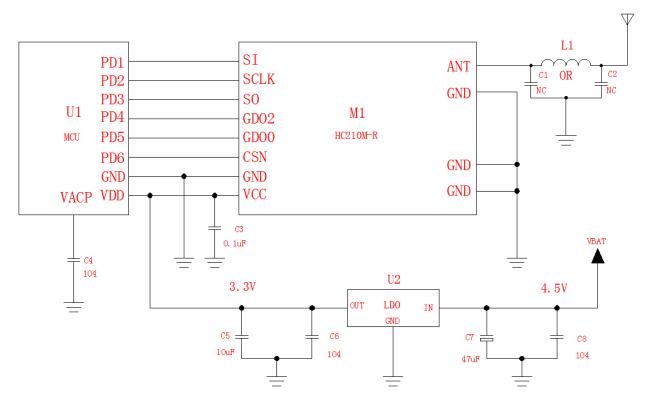


Figure 8 Typical Application Schematic

Table 13. BOM of Typical Application

Designator	Descriptions	Manufacturer
M1	Module HC210M-R 18.58*12.1*2mm RoHS	LJ ELECTRONICS
U1	IC 8 BIT MCU STM8S003F3 SSOP20 RoHS	MICROICHIP
U2	IC LDO XC6206P33PR 3.3V SOT-23 RoHS	TOREX
L1	Thick film resistor0R 5% 1/16W 0402 RoHS	ROHM
C1	CAP CER 0402 DO NOT FIT	
C2	CAP CER 0402 DO NOT FIT	
C3	CAP CER 0.1uF/25V 20% X7R 0402 RoHS	MURATA
C4	CAP CER 0.1uF/25V 20% X7R 0402 RoHS	MURATA
C5	CAP CER 10uF/16V 20% X5R 0402 RoHS	MURATA
C6	CAP CER 0.1uF/25V 20% X7R 0402 RoHS	MURATA
C7	CAP CER 47uF/16V 20% X5R 1206 RoHS	MURATA
C8	CAP CER 0.1uF/25V 20% X7R 0402 RoHS	MURATA

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8 Configuration Overview

HG210M-R can be configured to achieve optimum performance for many different applications. Configuration is done using the SPI interface. See Section 10 for more description of the SPI interface. The following key parameters can be programmed:

- Power-down / power up mode
- Crystal oscillator power-up / power-down
- Receive mode
- Carrier Frequency / RF channel Data
- rate
- Modulation format

- RX channel filter bandwidth
- Data buffering with the 64-byte RX FIFO Packet
- radio hardware support

Details of each configuration register can be found in Section 26 starting on page 45.

Figure 12 shows a simplified state diagram that explains the main **#C210M-R** states together with typical usage and current consumption. For detailed information on controlling the **#C210M-R** state machine, and a complete state diagram, see Section 18, starting on page 35.

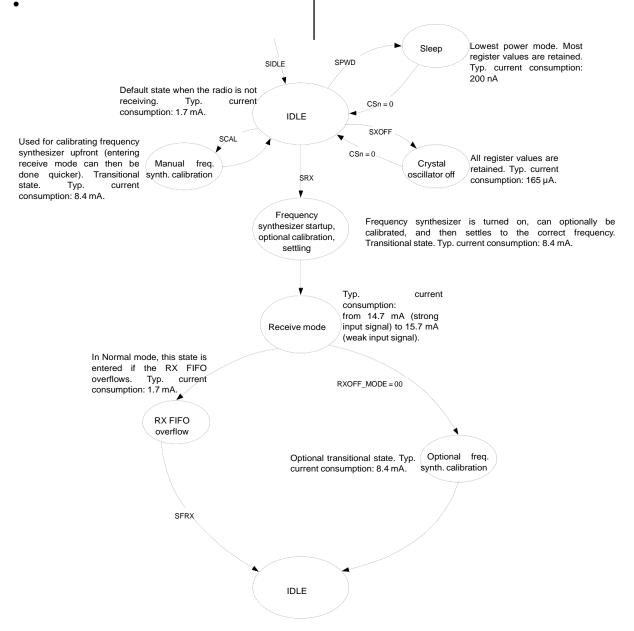


Figure 9: Simplified Radio Control State Diagram, with Typical Current Consumption at

1.2 kBaud Data Rate and MDMCFG2.DEM_DCFILT_OFF=1 (current optimized). Frequency Band = 868 MHz

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9 Configuration Software

HC210M-R can be configured using the SmartRF™ Studio software [4]. The SmartRF Studio software is highly recommended for obtaining optimum register settings, and for evaluating performance and functionality.

After chip reset, all the registers have default values as shown in the tables in Section 26. The optimum register setting might differ from the default value. After a reset all registers that shall be different from the default value therefore needs to be programmed through the SPI interface.

10 4-wire Serial Configuration and Data Interface

#C210M-R is configured via a simple 4-wire SPI-compatible interface (SI, SO, SCLK and CSn) where **#C210M-R** is the slave. This interface is also used to read buffered data. All transfers on the SPI interface are done most significant bit first.

All transactions on the SPI interface start with a header byte containing a R/W bit, a burst access bit (B), and a 6-bit address (A_5 - A_0).

The CSn pin must be kept low during transfers on the SPI bus. If CSn goes high during the transfer of a header byte or during read/write from/to a register, the transfer will be cancelled. The timing for the address and data transfer on the SPI interface is shown in Figure 13 with reference to Table 15.

When CSn is pulled low, the MCU must wait until **HC210M-R** SO pin goes low before starting to transfer the header byte. This indicates that the crystal is running. Unless the chip was in the SLEEP or XOFF states, the SO pin will always go low immediately after taking CSn low.

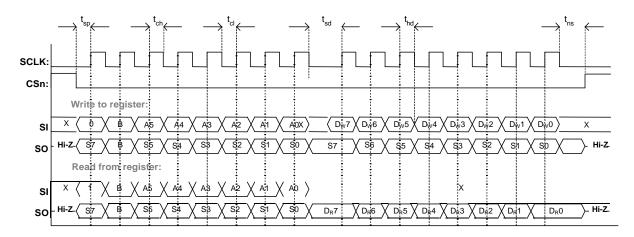


Figure 10: Configuration Registers Write and Read Operations

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Table 14: SPI Interface Timing Requirements

Parameter	Description		Min	Max	Units
f _{SCLK}	SCLK frequency 100 ns delay inserted between address byte and data byte (sing between address and data, and between each data byte (burst a	-	10	MHz	
	SCLK frequency, single access. No delay between address and of	data byte	-	9	
	SCLK frequency, burst access. No delay between address and data byte, or between data bytes				
t _{sp,pd}	CSn low to positive edge on SCLK, in power-down mode				μs
t _{sp}	CSn low to positive edge on SCLK, in active mode				ns
t _{ch}	Clock high		50	-	ns
t _{cl}	Clock low		50	-	ns
t _{rise}	Clock rise time		-	40	ns
t _{fall}	Clock fall time		-	40	ns
t _{sd}	Setup data (negative SCLK edge) to positive edge on SCLK	Single access	55	-	ns
	(t _{sd} applies between address and data bytes, and between data bytes)	Burst access	76	-	
t _{hd}	Hold data after positive edge on SCLK				ns
t _{ns}	Negative edge on SCLK to CSn high.		20	-	ns

Note: The minimum $t_{sp,pd}$ figure in Table 15 can be used in cases where the user does not read the CHIP_RDYn signal. CSn low to positive edge on SCLK when the chip is woken from power- down depends on the start-up time of the crystal being used. The 150 μ s in Table 15 is the crystal oscillator start-up time measured on [1] and [2] using crystal AT-41CD2 from NDK.

10.1 Chip Status Byte

When the header byte, data byte, or command strobe is sent on the SPI interface, the chip status byte is sent by the **#C210M-R** on the SO pin. The status byte contains key status signals, useful for the MCU. The first bit, s7, is the CHIP_RDYn signal and this signal must go low before the first positive edge of SCLK. The CHIP_RDYn signal indicates that the crystal is running.

Bits 6, 5, and 4 comprise the STATE value. This value reflects the state of the chip. The XOSC and power to the digital core are on in the IDLE state, but all other modules are in power down. The frequency and channel configuration should only be updated when the chip is in this state.

The last four bits (3:0) in the status byte contains <code>FIFO_BYTES_AVAILABLE</code>. For these bits to give any valid information, the R/W bit in the header byte must be set to 1. The <code>FIFO_BYTES_AVAILABLE</code> field will then contain the number of bytes that can be read from the RX FIFO. When <code>FIFO_BYTES_AVAILABLE=15</code>, 15 or more

bytes can be read. The RX FIFO should not be emptied before the complete packet has been received (see the HC210M-R Errata Notes [3] for more details).

Table 16 gives a status byte summary.

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Table 15: Status Byte Summary

Bits	Name	Descri	Description				
7	CHIP_RDYn		Stays high until power and crystal have stabilized. Should always be low when using the SPI interface.				
6:4	STATE[2:0]	Indicat	te machine mode				
		Value	State	Description			
			IDLE	IDLE state (Also reported for some transitional states instead of SETTLING or			
		001	RX	Receive mode			
		010	Reserved				
		011	Reserved				
		100	CALIBRATE	Frequency synthesizer calibration is running			
			SETTLING	PLL is settling			
		110	RXFIFO_OVERFLO W	RX FIFO has overflowed. Read out any useful data, then flush the FIFO with SFRX			
		111	Reserved				
3:0	FIFO_BYTES_AVAILABLE[3:	The nu	The number of bytes available in the RX FIFO				

10.2 Register Access

The configuration registers on the **HC210M-R** are located on SPI addresses from 0x00 to 0x2E. Table 31 on page 46 lists all configuration registers. It is highly recommended to use SmartRF Studio [4] to generate optimum register settings. The detailed description of each register is found in Section 26.1 and Section 26.2, starting on page 49. All configuration registers can be both written to and read. The R/W bit controls if the register should be written to or read. When writing to registers, the status byte is sent on the SO pin each time a header byte or data byte is transmitted on the SI pin. When reading from registers, the status byte is sent on the SO pin each time a header byte is transmitted on the SI pin.

10.3 SPI Read

When reading register fields over the SPI interface while the register fields are updated by the radio hardware (e.g. MARCSTATE or RXBYTES), there is a small, but finite, probability that a single read from the register

10.4 Command Strobes

Command Strobes may be viewed as single byte instructions to **#C210M-R**. By addressing a command strobe register, internal sequences will be started. These commands are used to disable the crystal oscillator, enable receive mode, enable calibration etc. The 8 command

Registers with consecutive addresses can be accessed in an efficient way by setting the burst bit (B) in the header byte. The address bits (A₅ - A₀) set the start address in an internal address counter. This counter is incremented by one each new byte (every 8 clock pulses). The burst access is either a read or a write access and must be terminated by setting CSn high.

For register addresses in the range 0x30 - 0x3D, the burst bit is used to select between status registers when burst bit is one, and command strobes when burst bit is zero. See more in Section 10.3 below. Because of this, burst access is not available for status registers and they must be accessed one at a time. The status registers can only be read.

is being corrupt. As an example, the probability of any single read from RXBYTES being corrupt, assuming the maximum data rate is used, is approximately 80 ppm. Refer to the **#C210M-R** Errata Notes [3] for more details.

strobes are listed in Table 30 on page 45.

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Note: An SIDLE strobe will clear all pending command strobes until IDLE state is reached. This means that if for example an SIDLE strobe is issued while the radio is in RX state, any other command strobes issued before the radio reaches IDLE state will be ignored.

The command strobe registers are accessed by transferring a single header byte (no data is being transferred). That is, only the R/W bit, the burst access bit (set to 0), and the six address bits (in the range 0x30 through 0x3D)

are written. The R/W bit should be set to one if the FIFO_BYTES_AVAILABLE field in the status byte should be interpreted.

When writing command strobes, the status byte is sent on the SO pin.

A command strobe may be followed by any other SPI access without pulling CSn high. However, if an SRES strobe is being issued, one will have to wait for SO to go low again before the next header byte can be issued as shown in Figure 14. The command strobes are executed immediately, with the exception of the SPWD and the SXOFF strobes, which are executed when CSn goes high.

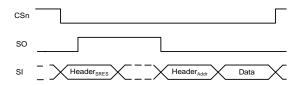


Figure 11: SRES Command Strobe

10.5 RX FIFO Access

The 64-byte RX FIFO is accessed through the 0x3F address. The RX FIFO is write-only and the R/W bit should therefore be one.

The burst bit is used to determine if the RX FIFO access is a single byte access or a burst access. The single byte access method expects a header byte with the burst bit set to zero and one data byte. After the data byte, a new header byte is expected; hence, CSn can remain low. The burst access method expects one header byte and then consecutive data bytes until terminating the access by setting CSn high.

The following header bytes access the RX FIFO:

- 0xBF: Single byte access to RX FIFO
- · 0xFF: Burst access to RX FIFO

The RX FIFO may be flushed by issuing a SFRX command strobe. A SFRX command strobe can only be issued in the IDLE, or RXFIFO_OVERFLOW states. The RX FIFO is flushed when going to the SLEEP state.

Figure 15 gives a brief overview of different register access types possible.

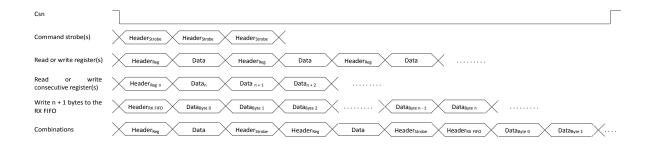


Figure 12: Register Access Types

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11 Microcontroller Interface and Pin Configuration

In a typical system, **#G210M-R** will interface to a microcontroller. This microcontroller must be able to:

• Program **#C210M-R** into different modes

11.1 Configuration Interface

The microcontroller uses four I/O pins for the SPI configuration interface (SI, SO, SCLK and

11.2 General Control and Status Pins

The **IG210M-R** has two dedicated configurable pins (GDO0 and GDO2) and one shared pin (GDO1) that can output internal status information useful for control software. These pins can be used to generate interrupts on the MCU. See Section 23 on page 41 for more details on the signals that can be programmed.

12 Data Rate Programming

The data rate expected in receive mode is programmed by the MDMCFG3.DRATE_M and the MDMCFG4.DRATE_E configuration registers. The data rate is given by the formula below. As the formula shows, the programmed data rate depends on the crystal frequency.

$$R_{DATA} = \frac{(256 + DRATE_M) \cdot 2^{DRATE_E}}{2^{28}} \cdot f_{XOSC}$$

The following approach can be used to find suitable values for a given data rate:

$$DRATE_E = log_2\left(\frac{R_{DATA} \cdot 2^{20}}{f_{XOSC}}\right)$$

$$DRATE_{M} = \frac{R_{DATA} \cdot 2^{20}}{f_{XOSC} \cdot 2^{DRATE_E}} - 256$$

If DRATE_M is rounded to the nearest integer and becomes 256, increment DRATE_E and use DRATE M = 0.

13 Receiver Channel Filter Bandwidth

In order to meet different channel width requirements, the receiver channel filter is programmable. The MDMCFG4.CHANBW_E and MDMCFG4.CHANBW_M configuration registers control the receiver channel filter bandwidth,

· Read buffered data

 Read back status information via the 4-wire SPIbus configuration interface (SI, SO, SCLK and CSn)

CSn). The SPI is described in Section 10 on page 21.

GDO1 is shared with the SO pin in the SPI interface. The default setting for GDO1/SO is 3-state output. By selecting any other of the programming options, the GDO1/SO pin will become a generic pin. When CSn is low, the pin will always function as a normal SO pin.

The data rate can be set from 0.6 kBaud to 500 kBaud with the minimum step size according to Table 17 below. See Table 3 for the minimum and maximum data rates for the different modulation formats.

Table 16: Data Rate Step Size (assuming a 26 MHz crystal)

	Min Data Rate	Typical Data Rate	Max Data Rate	Data rate Step
	0.6	1.0	0.79	0.0015
	0.79	1.2	1.58	0.0031
	1.59	2.4	3.17	0.0062
9	3.17	4.8	6.33	0.0124
	6.35	9.6	12.7	0.0248
	12.7	19.6	25.3	0.0496
	25.4	38.4	50.7	0.0992
	50.8	76.8	101.4	0.1984
	101.6	153.6	202.8	0.3967
	203.1	250	405.5	0.7935
	406.3	500	500	1.5869

which scales with the crystal oscillator frequency. The following formula gives the relation between the register settings and the channel filter bandwidth:

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$$BW_{channel} = \frac{f_{XOSC}}{8 \cdot (4 + CHANBW_M) \ 2^{CHANBW_E}}$$

Table 18 lists the channel filter bandwidths supported by the **#C210M-R**.

Table 17: Channel Filter Bandwidths [kHz] (assuming a 26 MHz crystal)

MDMCFG4.	MDMCFG4.CHANBW_					
CHANBW_	00	01	10	11		
00	812	406	203	102		
01	650	325	162	81		
10	541	270	135	68		
11	464	232	116	58		

For best performance, the channel filter bandwidth should be selected so that the signal bandwidth occupies at most 80% of the channel filter bandwidth. The channel centre tolerance due to crystal inaccuracy should also be subtracted from the channel filter

bandwidth. The following example illustrates this:

With the channel filter bandwidth set to 500 kHz, the signal should stay within 80% of 500 kHz, which is 400 kHz. Assuming 915 MHz frequency and ±20 ppm frequency uncertainty for both the transmitting device and the receiving device, the total frequency uncertainty is

±37 kHz. If the whole transmitted signal bandwidth is to be received within 400 kHz, the transmitted signal bandwidth should be maximum 400 kHz - 2·37 kHz, which is 326 kHz.

±40 ppm of 915 MHz, which is

By compensating for a frequency offset between the transmitter and the receiver, the filter bandwidth can be reduced and the sensitivity can be improved, see more in DN005 [9] and in Section 14.1.

14 Demodulator, Symbol Synchronizer, and Data Decision

#C210M-R contains an advanced and highly configurable demodulator. Channel filtering and frequency offset compensation is performed digitally. To generate the RSSI level

(see Section 17.2 for more information), the signal level in the channel is estimated. Data filtering is also included for enhanced performance.

14.1 Frequency Offset Compensation

The **HC210M-R** has a very fine frequency resolution (see Table 9). This feature can be used to compensate for frequency offset and drift.

When using 2-FSK, GFSK, or 4-FSK modulation, the demodulator will compensate for the offset between the transmitter and receiver frequency within certain limits, by estimating the centre of the received data. The frequency offset compensation configuration is controlled from the FOCCFG register. By compensating for a large frequency offset between the transmitter and the receiver, the sensitivity can be improved, see DN005 [9].

The tracking range of the algorithm is selectable as fractions of the channel bandwidth with the <code>FOCCFG.FOC_LIMIT</code> configuration register.

If the FOCCFG.FOC_BS_CS_GATE bit is set, the offset compensator will freeze until carrier sense asserts. This may be useful when the radio is in RX for long periods with no traffic,

since the algorithm may drift to the boundaries when trying to track noise.

The tracking loop has two gain factors, which affects the settling time and noise sensitivity of the algorithm. FOCCFG.FOC_PRE_K sets the gain before the sync word is detected, and FOCCFG.FOC_POST_K selects the gain after the sync word has been found.

Note: Frequency offset compensation is not supported for OOK modulation

The estimated frequency offset value is available in the FREQEST status register. This can be used for permanent frequency offset compensation. By writing the value from FREQEST into FSCTRLO.FREQOFF, the

frequency synthesizer will automatically be adjusted according to the estimated frequency offset. More details regarding this permanent frequency compensation algorithm can be found in DN015 [6].

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14.2 Bit Synchronization

The bit synchronization algorithm extracts the clock from the incoming symbols. The algorithm requires that the expected data rate is programmed as described in Section 12 on

page 25. Re-synchronization is performed continuously to adjust for error in the incoming symbol rate.

14.3 Byte Synchronization

Byte synchronization is achieved by a continuous sync word search. The sync word is a 16 bit configurable field (can be repeated to get a 32 bit) that must be inserted at the start of the packet by the transmitter (for example the **HC210M-T**, **CC1101**, or **CC1101**). The MSB in the sync word must be transmitted first. The demodulator uses this field to find the byte boundaries in the stream of bits. The sync word will also function as a system identifier, since only packets with the correct predefined

sync word will be received if the sync word detection is enabled in register MDMCFG2 (see Section 17.1). The sync word detector correlates against the user-configured 16 or 32 bit sync word. The correlation threshold can be set to 15/16, 16/16, or 30/32 bits match. The sync word can be further qualified using the preamble quality indicator mechanism described below and/or a carrier sense condition. The sync word is configured through the SYNC1 and SYNC0 registers.

15 Packet Handling Hardware Support

The **HC210M-R** has built-in hardware support for packet oriented radio protocols and the packet handler can be configured to implement the following (if enabled):

- Preamble detection
- Sync word detection
- CRC computation and CRC check One
- byte address check
- Packet length check (length byte checked against a programmable maximum length)

Optionally, two status bytes (see Table 19 and Table 20) with RSSI value and CRC status can be appended in the RX FIFO.

Table 18: Received Packet Status Byte 1 (first byte appended after the data)

Bit	Field Name	Description
7:0	RSSI	RSSI value

Table 19: Received Packet Status Byte 2 (second byte appended after the data)

Bit	Field Name	Description
7	CRC_OK	1: CRC for received data OK (or CRC disabled)
		0: CRC error in received data
6:0	Reserved	

Note: Register fields that control the packet handling features should only be altered when **#C210M-R** is in the IDLE state.

15.1 Packet Format

The **#C210M-R** can be configured to receive packets of different format and the packet should consists of the following items (see Figure 16):

Preamble

- Synchronization word
- Optional length byte
- Optional address byte
- Payload
- Optional 2 byte CRC

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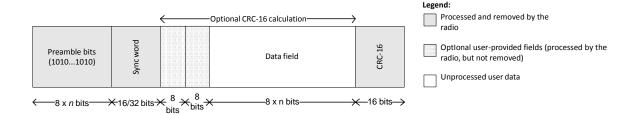


Figure 13: Packet Format

The preamble pattern is an alternating sequence of ones and zeros that the receiver uses for bit synchronisation.

The synchronization word is a two-byte value set in the SYNC1 and SYNC0 registers. The sync word provides byte synchronization of the incoming packet. A one-byte sync word can be emulated by setting the SYNC1 value to the preamble pattern. It is also possible to emulate a 32 bit sync word by setting MDMCFG2.SYNC_MODE to 3 or 7. The sync word searched for is the two-byte sync word repeated twice.

#C210M-R supports both constant packet length protocols and variable length protocols. Variable or fixed packet length mode can be used for packets up to 255 bytes. For longer packets, infinite packet length mode must be used.

Fixed packet length mode is selected by setting PKTCTRLO.LENGTH_CONFIG=0. The desired packet length is set by the PKTLEN register. This value must be different from 0.

In variable packet length mode, PKTCTRLO.LENGTH_CONFIG=1, the packet length is configured by the first byte after the sync word. The packet length is defined as the payload data, excluding the length byte and the optional CRC. The PKTLEN register is used to set the maximum packet length allowed. Any packet received with a length byte with a value greater than PKTLEN will be discarded. The PKTLEN value must be different from 0.

With PKTCTRL0.LENGTH_CONFIG=2, the packet length is set to infinite and reception will continue until turned off manually. As described in the next section, this can be used to support packet formats with different length configuration than natively supported by **HC210M-R**.

Note: The minimum packet length supported (excluding the optional length byte and CRC) is one byte of payload data.

15.1.1 Arbitrary Length Field Configuration

The packet length register, PKTLEN, can be reprogrammed during RX. In combination with fixed length packet (PKTCTRL0.LENGTH CONFIG=0), this opens the possibility to have a different length field configuration than supported for variable length packets (in variable packet length mode the length byte is the first byte after the sync word). At the start of reception, the packet length is set to a large value. The MCU reads out enough bytes to interpret the length field in the packet. Then the PKTLEN value is set according to this value. The end of packet will occur when the byte counter in the packet handler is equal to the PKTLEN register. Thus, the MCU must be able to program the correct length, before the internal counter reaches the packet length.

15.1.2 Packet Length > 255

The packet automation control register, PKTCTRL0, can be reprogrammed during RX. This opens the possibility to receive packets that are longer than 256 bytes and still be able to use the packet handling hardware support. At the start of the packet, the infinite packet length mode

(PKTCTRL0.LENGTH_CONFIG=2) must be active. When receiving, the MCU reads out enough bytes to interpret the length field in the packet and sets the PKTLEN register to mod(length, 256). When less than 256 bytes remains of the packet, the MCU disables infinite packet length mode and activates fixed packet length

(PKTCTRLO.LENGTH_CONFIG=0). When the internal byte counter reaches the PKTLEN value, the reception ends (the radio enters the state determined by RXOFF MODE). Automatic

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CRC appending/checking can also be used (by setting PKTCTRL0.CRC EN=1).

When for example a 600-byte packet is to be received, the MCU should do the following (see also Figure 17)

- Set PKTCTRLO.LENGTH CONFIG=2.
- Receive enough bytes to interpret the length field
- Program the PKTLEN register to mod(600, 256) = 88.
- Receive at least 345 bytes (600 255) Set
- PKTCTRL0.LENGTH_CONFIG=0.
- The reception ends when the packet counter reaches 88. A total of 600 bytes have been received.

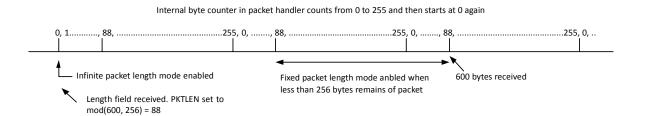


Figure 14: Packet Length > 255

15.2 Packet Filtering

HC210M-R supports three different types of packet filtering; address filtering, maximum length filtering, and CRC filtering.

15.2.1 Address Filtering

Setting PKTCTRL1.ADR_CHK to any other value than zero enables the packet address filter. The packet handler engine will compare the destination address byte in the packet with the programmed node address in the ADDR register and the 0x00 broadcast address when PKTCTRL1.ADR_CHK=10 or both the 0x00 and 0xFF broadcast addresses when PKTCTRL1.ADR_CHK=11. If the received address matches a valid address, the packet is received and written into the RX FIFO. If the address match fails, the packet is discarded and receive mode restarted (regardless of the MCSM1.RXOFF_MODE setting).

If the received address matches a valid address when using infinite packet length mode and address filtering is enabled, 0xFF will be written into the RX FIFO followed by the address byte and then the payload data.

15.2.2 Maximum Length Filtering

In variable packet length mode, PKTCTRL0.LENGTH_CONFIG=1, the PKTLEN.PACKET LENGTH register value is

used to set the maximum allowed packet length. If the received length byte has a larger value than this, the packet is discarded and receive mode restarted (regardless of the MCSM1.RXOFF_MODE setting).

15.2.3 CRC Filtering

The filtering of a packet when CRC check fails is enabled by setting PKTCTRL1.CRC_AUTOFLUSH=1. The CRC auto flush function will flush the entire RX FIFO if the CRC check fails. After auto flushing the RX FIFO, the next state depends on the MCSM1.RXOFF MODE setting.

When using the auto flush function, maximum packet length is 63 bytes in variable packet length mode and 64 bytes in fixed packet length Note that when mode. PKTCTRL1.APPEND STATUS enabled, is maximum allowed packet length is reduced by two bytes in order to make room in the RX FIFO for the two status bytes appended at the end of the packet. Since the entire RX FIFO is flushed when the CRC check fails, the previously received packet must be read out of the RX FIFO before receiving the current packet. The MCU must not read from the current packet until the CRC has been checked as OK.

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15.3 Packet Handling

In RX mode, the demodulator and packet handler will search for a valid sync word. When found, the demodulator has obtained both bit and byte synchronization and will receive the first payload byte.

When variable packet length mode is enabled, the first byte is the length byte. The packet handler stores this value as the packet length and receives the number of bytes indicated by the length byte. If fixed packet length mode is used, the packet handler will accept the programmed number of bytes.

15.4 Packet Handling in Firmware

When implementing a packet oriented radio protocol in firmware, the MCU needs to know when a packet has been received. Additionally, for packets longer than 64 bytes, the RX FIFO needs to be read while in RX mode. This means that the MCU needs to know the number of bytes that can be read from the RX FIFO. There are two possible solutions to get the necessary status information:

a) Interrupt Driven Solution

The GDO pins can be used to give an interrupt when a sync word has been received or when a complete packet has been received by setting ${\tt IOCFGx.GDOx_CFG=0x06}$. In addition, there are two configurations for the ${\tt IOCFGx.GDOx_CFG}$ register that can be used as an interrupt source to provide information on how many bytes that are in the RX FIFO (${\tt IOCFGx.GDOx_CFG=0x00}$ and ${\tt IOCFGx.GDOx_CFG=0x01}$). See Table 29 for more information.

16 Modulation Formats

#C210M-R supports amplitude, frequency, and phase shift modulation formats. The desired modulation format is set in the MDMCFG2.MOD_FORMAT register.

Optionally, if the data has been Manchester coded on the transmitter side it can be

16.1 Frequency Shift Keying

#C210M-R supports 2-(G)FSK and 4-FSK modulation. When selecting 4-FSK, the preamble and sync word to be received needs to be 2-FSK (see Figure 13).

Next, the packet handler optionally checks the address and only continues the reception if the address matches. If automatic CRC check is enabled, the packet handler computes CRC and matches it with the appended CRC checksum.

At the end of the payload, the packet handler will optionally write two extra packet status bytes (see Table 19 and Table 20) that contain CRC status, link quality indication, and RSSI value.

b) SPI Polling

The PKTSTATUS register can be polled at a given rate to get information about the current GDO2 and GDO0 values respectively. The RXBYTES register can be polled at a given rate to get information about the number of bytes in the RX FIFO. Alternatively, the number of bytes in the RX FIFO can be read from the chip status byte returned on the MISO line each time a header byte, data byte, or command strobe is sent on the SPI bus.

It is recommended to employ an interrupt driven solution since high rate SPI polling reduces the RX sensitivity. Furthermore, as explained in Section 10.3 and the **HC210M-R** Errata Notes [3], when using SPI polling, there is a small, but finite, probability that a single read from registers PKTSTATUS, and RXBYTES is being corrupt. The same is the case when reading the chip status byte.

decoded by the demodulator. This option is enabled by setting MDMCFG2.MANCHESTER EN=1.

Note: Manchester encoding is not supported at the same time as using 4- FSK modulation

When 2-FSK/GFSK/4-FSK modulation is used, the DEVIATN register specifies the expected frequency deviation of incoming signals in RX and should be the same as the deviation of the



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transmitted signal for demodulation to be performed reliably and robustly.

The frequency deviation is programmed with the DEVIATION_M and DEVIATION_E values in the DEVIATN register. The value has an exponent/mantissa form, and the resultant deviation is given by:

$$f_{dev} = \frac{f_{XOSC}}{2^{17}} \cdot (8 + DEVIATION_M) \cdot 2^{DEVIATION_E}$$

The symbol encoding is shown in Table 21.

Format	Symbol	Coding	
2-FSK/GFSK	"0"	Deviation	
2-FSN/GFSN	"1"	+ Deviation	
	"01"	Deviation	
4.501/	"00"	–1/3·Deviation	
4-FSK	"10"	+1/3·Deviation	
	"11"	+ Deviation	

Table 20: Symbol Encoding for 2-FSK/GFSK and 4-FSK Modulation

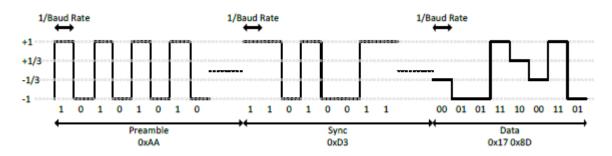


Figure 15: Data Sent Over the Air (MDMCFG2.MOD FORMAT=100)

16.2 Amplitude Modulation

The amplitude modulation supported by **#C210M-R** is On-Off Keying (OOK).

When using OOK, the AGC settings from the SmartRF Studio [4] preferred FSK

settings are not optimum. DN022 [8] gives guidelines on how to find optimum OOK settings from the preferred settings in SmartRF Studio [4]. The <code>DEVIATN</code> register setting has no effect when using OOK.

17 Received Signal Qualifiers and RSSI

#C210M-R has several qualifiers that can be used to increase the likelihood that a valid sync word is detected:

17.1 Sync Word Qualifier

If sync word detection is enabled in the MDMCFG2 register, the **MC210M-R** will not start filling the RX FIFO and perform the packet filtering described in Section 15.2 before a valid sync word has been detected. The sync word qualifier mode is set by MDMCFG2.SYNC_MODE and is summarized in Table 22. Carrier sense in Table 22 is described in Section 17.3.

- Sync Word Qualifier
- RSSI
- Carrier Sense

MDMCFG2. SYNC_MOD Sync Word Qualifier Mode	
000	No preamble/sync
001	15/16 sync word bits detected
010	16/16 sync word bits detected
011	30/32 sync word bits detected
100	No preamble/sync + carrier sense above threshold
101	15/16 + carrier sense above threshold
110	16/16 + carrier sense above threshold
111	30/32 + carrier sense above threshold

Table 21: Sync Word Qualifier Mode

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17.2 RSSI

The RSSI value is an estimate of the signal power level in the chosen channel. This value is based on the current gain setting in the RX chain and the measured signal level in the channel.

In RX mode, the RSSI value can be read continuously from the RSSI status register until the demodulator detects a sync word (when sync word detection is enabled). At that point the RSSI readout value is frozen until the next time the chip enters the RX state.

Note: It takes some time from the radio enters RX mode until a valid RSSI value is present in the RSSI register. Please see DN505 [7] for details on how the RSSI response time can be estimated.

The RSSI value is given in dBm with a 1/2 dB resolution. The RSSI update rate, f_{RSSI}, depends on the receiver filter bandwidth (BW_{channel} is defined in Section 13) AGCCTRLO.FILTER LENGTH.

Table 22: Typical RSSI_offset Values

£	_	$2 \cdot BW_{channel}$
JRSSI	_	8 · 2 ^{FILTER_LENGTH}

If PKTCTRL1.APPEND STATUS is enabled, the last RSSI value of the packet is automatically added to the first byte appended after the payload.

The RSSI value read from the RSSI status register is a 2"s complement number. The following procedure can be used to convert the RSSI reading to an absolute power level (RSSI dBm)

- 1) Read the RSSI status register
- 2) Convert the reading from a hexadecimal number to a decimal number (RSSI_dec)
- 3) If RSSI_dec ≥ 128 then RSSI_dBm = (RSSI_dec - 256)/2 - RSSI_offset
- Else if RSSI_dec < 128 then RSSI_dBm = (RSSI_dec)/2 - RSSI_offset

Table 23 gives typical values for the RSSI_offset. Figure 19 and Figure 20 show typical plots of RSSI readings as a function of input power level for different data rates.

Data rate [kBaud]	RSSI_offset [dB], 433 MHz	RSSI_offset [dB], 868 MHz
1.2	74	74
38.4	74	74
250	74	74
500	74	74

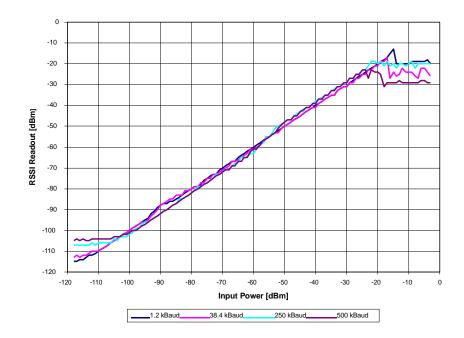


Figure 16: Typical RSSI Value vs. Input Power Level for Different Data Rates at 433 MHz

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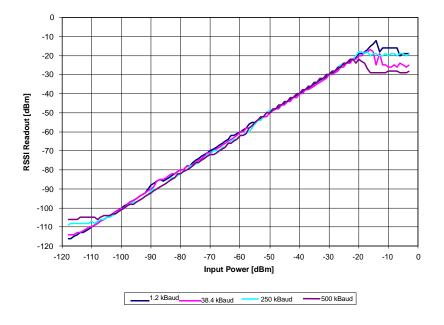


Figure 17: Typical RSSI Value vs. Input Power Level for Different Data Rates at 868 MHz

17.3 Carrier Sense (CS)

Carrier sense (CS) is used as a sync word qualifier and can be asserted based on two conditions which can be individually adjusted:

- CS is asserted when the RSSI is above a programmable absolute threshold, and deasserted when RSSI is below the same threshold (with hysteresis). See more in Section 17.3.1.
- CS is asserted when the RSSI has increased with a programmable number of dB from one RSSI sample to the next, and deasserted when RSSI has decreased with the same number of dB. This setting is not dependent on the absolute signal level and is thus useful to detect signals in environments with time varying noise floor. See more in Section 17.3.2.

Carrier sense can be used as a sync word qualifier that requires the signal level to be higher than the threshold for a sync word search to be performed and is set by setting MDMCFG2 . The carrier sense signal can be observed on pins of the GDO one by setting IOCFGx.GDOx CFG=14 and in the status register bit PKTSTATUS.CS.

17.3.1 CS Absolute Threshold

The absolute threshold related to the value depends on the following register fields:

- AGCCTRL2.MAX LNA GAIN
- AGCCTRL2.MAX DVGA GAIN
- AGCCTRL1.CARRIER SENSE ABS THR
- AGCCTRL2.MAGN TARGET

given For AGCCTRL2.MAX LNA GAIN and AGCCTRL2.MAX DVGA GAIN settings, the absolute threshold can be adjusted ±7 dB in steps of dΒ usina 1 CARRIER SENSE ABS THR.

The ${\tt MAGN_TARGET}$ setting is a compromise blocker tolerance/selectivity sensitivity. The value sets the desired signal level in the channel into the demodulator. Increasing this value reduces the headroom for blockers, and therefore close-in selectivity. It is strongly recommended to use SmartRF Studio [4] to generate the correct MAGN TARGET setting. Table 24 and Table 25 show the typical RSSI readout values at the CS threshold at 2.4 kBaud and 250 kBaud data rate respectively. The default reset value for CARRIER SENSE ABS THR = 0 (0

been used. MAGN TARGET = 3 (33 dB) and 7 (42 dB) have been used for 2.4 kBaud and 250 kBaud data rate respectively. For other data rates, the user must generate similar tables to find the CS absolute threshold.

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		MAX_	MAX_DVGA_GAIN[1:0]			
		00	01	10	11	
	000	-97.5	-91.5	-85.5	-79.5	
	001	-94	-88	-82.5	-76	
:0]	010	-90.5	-84.5	-78.5	-72.5	
GAIN[2:0]	011	-88	-82.5	-76.5	-70.5	
_GA	100	-85.5	-80	-73.5	-68	
N.	101	-84	-78	-72	-66	
MAX_LNA	110	-82	-76	-70	-64	
MA	111	-79	-73.5	-67	-61	

Table 23: Typical RSSI Value in dBm at CS Threshold with MAGN_TARGET = 3 (33 dB) at 2.4 kBaud, 868 MHz

		MAX_DVGA_GAIN[1:0]		:0]	
		00	01	10	11
	000	-90.5	-84.5	-78.5	-72.5
	001	-88	-82	-76	-70
<u>.</u>	010	-84.5	-78.5	-72	-66
GAIN[2:0]	011	-82.5	-76.5	-70	-64
GA	100	-80.5	-74.5	-68	-62
Y Y	101	-78	-72	-66	-60
MAX_LNA	110	-76.5	-70	-64	-58
Ψ	111	-74.5	-68	-62	-56

Table 24: Typical RSSI Value in dBm at CS Threshold with MAGN_TARGET = 7 (42 dB) at 250 kBaud, 868 MHz

If the threshold is set high, i.e. only strong signals are wanted, the threshold should be adjusted upwards by first reducing the MAX_LNA_GAIN value and then the MAX_DVGA_GAIN value. This will reduce power consumption in the receiver front end, since the highest gain settings are avoided.

17.3.2 CS Relative Threshold

The relative threshold detects sudden changes in the measured signal level. This setting does not depend on the absolute signal level and is thus useful to detect signals in environments with a time varying noise floor. The register field AGCCTRL1.CARRIER SENSE REL THR

is used to enable/disable relative CS, and to select threshold of 6 dB, 10 dB, or 14 dB RSSI change.

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18 Radio Control

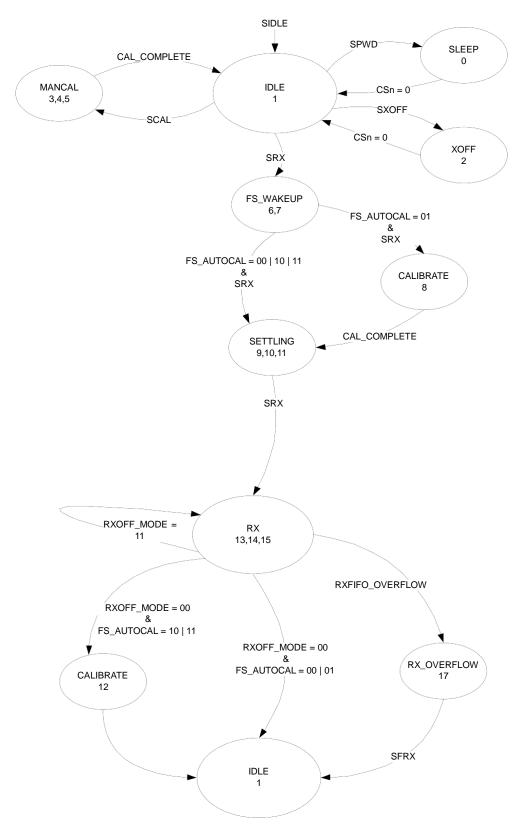


Figure 18: Complete Radio Control State Diagram

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HG210M-R has a built-in state machine that is used to switch between different operational states (modes). The change of state is done either by using command strobes or by internal events such as RX FIFO overflow.

A simplified state diagram, together with typical usage and current consumption, is

shown in Figure 12 on page 20. The complete radio control state diagram is shown in Figure 21. The numbers refer to the state number readable in the MARCSTATE status register. This register is primarily for test purposes.

18.1 Power-On Start-Up Sequence

When the power supply is turned on, the system must be reset. This is achieved by one of the two sequences described below, i.e. automatic poweron reset (POR) or manual reset. After the automatic power-on reset or manual reset, it is also recommended to change the signal that is output on the GDO0 pin. The default setting is to output a clock

signal with a frequency of CLK_XOSC/192.
However, to optimize performance in RX, an alternative GDO setting from the settings

found in Table 29 on page 42 should be selected

18.1.1 Automatic POR

A power-on reset circuit is included in the HC210M-R. The minimum requirements stated in Table 11 must be followed for the power-on reset to function properly. The internal power- up sequence is completed when CHIP_RDYN goes low. CHIP_RDYN is observed on the SO pin after CSn is pulled low. See Section 10.1 for more details on CHIP_RDYN.

When the **#G210M-R** reset is completed, the chip will be in the IDLE state and the crystal oscillator will be running. If the chip has had sufficient time for the crystal oscillator to stabilize after the power-on-reset, the SO pin will go low immediately after taking CSn low. If CSn is taken low before reset is completed, the SO pin will first go high, indicating that the crystal oscillator is not stabilized, before going low as shown in Figure 22.

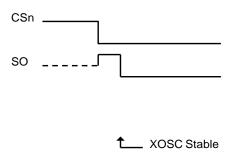


Figure 20: Power-On Reset

18.1.2 Manual Reset

The other global reset possibility on **#6210M-R** uses the SRES command strobe. By issuing this strobe, all internal registers and states are set to the default, IDLE state. The manual power-up sequence is as follows (see Figure 23):

- Set SCLK = 1 and SI = 0.
- Strobe CSn low / high.
- Hold CSn low and then high for at least 40 µs relative to pulling CSn low
- Pull CSn low and wait for SO to go low (CHIP RDYn).
- Issue the SRES strobe on the SI line.
- When SO goes low again, reset is complete and the chip is in the IDLE state.

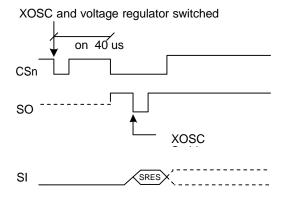


Figure 19: Power-On Reset with SRES

Note that the above reset procedure is only required just after the power supply is first turned on. If the user wants to reset the **#C210M-R** after this, it is only necessary to issue an SRES command strobe.

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18.2 Crystal Control

The crystal oscillator (XOSC) is either automatically controlled or always on, if MCSMO.XOSC FORCE ON is set.

In the automatic mode, the XOSC will be turned off if the SXOFF or SPWD command strobes are issued; the state machine then goes to XOFF or SLEEP respectively. This can only be done from the IDLE state. The XOSC will be turned off when CSn is released (goes high). The XOSC will be automatically turned on again when CSn goes low. The

state machine will then go to the IDLE state. The SO pin on the SPI interface must be pulled low before the SPI interface is ready to be used as described in Section 10.1 on page 22.

If the XOSC is forced on, the crystal will always stay on even in the SLEEP state.

Crystal oscillator start-up time depends on crystal ESR and load capacitances. The electrical specification for the crystal oscillator can be found in Section 4.3 on page 12.

18.3 Voltage Regulator Control

The voltage regulator to the digital core is controlled by the radio controller. When the chip enters the SLEEP state which is the state with the lowest current consumption, the voltage regulator is disabled. This occurs after CSn is released when a SPWD command

strobe has been sent on the SPI interface. The chip is then in the SLEEP state. Setting CSn low again will turn on the regulator and crystal oscillator and make the chip enter the IDLE state.

18.4 Receive Mode (RX)

Receive mode is activated directly by the MCU by using the SRX command strobe.

The frequency synthesizer must be calibrated regularly. **HC210M-R** has one manual calibration option (using the SCAL strobe), and three automatic calibration options that are controlled by the MCSMO.FS AUTOCAL setting:

- Calibrate when going from IDLE to RX
- Calibrate when going from RX to IDLE automatically¹
- Calibrate every fourth time when going from RX to IDLE automatically¹

If the radio goes from RX to IDLE by issuing an SIDLE strobe, calibration will not be performed. The calibration takes a constant number of XOSC cycles; see Table 26 for timing details regarding calibration.

When RX is activated, the chip will remain in receive mode until a packet is successfully received or until RX mode terminated due to lack of carrier sense (see Section 18.5). The probability that a false sync word is detected can be reduced by using CS together with maximum sync word length as described in Section 17. After a packet is successfully received, the radio controller goes to the state indicated by the MCSM1.RXOFF_MODE setting. The possible destinations are:

RX: Start search for a new packet

Note: When MCSM1.RXOFF_MODE=11 and a packet has been received, it will take some time before a valid RSSI value is present in the RSSI register again even if the radio has never exited RX mode. This time is the same as the RSSI response time discussed in DN505 [7].

The ${\tt SIDLE}$ command strobe can always be used to force the radio controller to go to the IDLE state.

18.5 RX Termination

If the system expects the transmission to have started when entering RX mode, the $\texttt{MCSM2.RX_TIME_RSSI}$ function can be used. The radio controller will then terminate RX if the first valid carrier sense sample indicates no carrier (RSSI below threshold). See Section

17.3 on page 33 for details on Carrier Sense.

For OOK modulation, lack of carrier sense is only considered valid after eight symbol periods. Thus, the MCSM2.RX_TIME_RSSI function can be used in OOK mode when the distance between two "1" symbols is eight or less.

If RX terminates due to no carrier sense when the MCSM2.RX_TIME_RSSI function is used, the radio will always go back to IDLE,

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IDLE

¹ Not forced in IDLE by issuing an SIDLE strobe



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regardless of the MCSM1.RXOFF MODE setting.

18.6 Timing

Overall State Transition Times

The main radio controller needs to wait in certain states in order to make sure that the internal analog/digital parts have settled down and are ready to operate in the new states. A number of factors are important for the state transition times:

- The crystal oscillator frequency, fxosc The
- value of the TEST0, TEST1, and FSCAL3 registers

Table 26 shows timing in crystal clock cycles for key state transitions.

Table 25: Overall State Transition Times (Example for 26 MHz crystal oscillator, 250 kBaud data rate, and TEST0 = 0x0B (maximum calibration time)).

Description	Transition Time	Transition Time [µs]
IDLE to RX, no calibration	1953/f _{xosc}	75.1
IDLE to RX, with calibration	1953/f _{xosc} + FS calibration Time	799
RX to IDLE, no calibration	2/f _{xosc}	~0.1
RX to IDLE, with calibration	2/f _{xosc} + FS calibration Time	724
Manual calibration	283/f _{xosc} + FS calibration Time	735

18.6.2 Frequency Synthesizer Calibration Time

Table 27 summarizes the frequency synthesizer (FS) calibration times for possible settings of

TESTO and

The calibration time can be reduced from 712/724 μs to 145/157 μs . See Section 25.2 on page 44 for more details.

Table 26. Frequency Synthesizer Calibration Times (26/27 MHz crystal)

TESTO	FSCAL3.CHP_CURR_CAL_ EN	FS Calibration Time $f_{xosc} = 26$	FS Calibration Time $f_{xosc} = 27$
0x09	00 _b	$3764/f_{xosc} = 145 \text{ us}$	$3764/f_{xosc} = 139 \text{ us}$
0x09	10 _b	$18506/f_{xosc} = 712 \text{ us}$	$18506/f_{xosc} = 685 \text{ us}$
0x0B	00 _b	$4073/f_{xosc} = 157 \text{ us}$	$4073/f_{xosc} = 151 \text{ us}$
0x0B	10 _b	$18815/f_{xosc} = 724 \text{ us}$	$18815/f_{xosc} = 697 \text{ us}$

19 RX FIFO

The **HC210M-R** contains a 64-byte RX FIFO for received data and the SPI interface is used to read the RX FIFO (see Section 10.5 for more details). The FIFO controller will detect overflow in the RX FIFO.

When reading the RX FIFO the MCU must avoid reading it past its empty value since a

RX FIFO underflow will result in an error in the data read out of the RX FIFO.

The chip status byte that is available on the SO pin while transferring the SPI header contains the fill grade of the RX FIFO (R/W=1). Section 10.1 on page 22 contains more details on this.

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The number of bytes in the RX FIFO can also be read from the status register RXBYTES.NUM_RXBYTES. If a received data byte is written to the RX FIFO at the exact same time as the last byte in the RX FIFO is read over the SPI interface, the RX FIFO pointer is not properly updated and the last read byte will be duplicated. To avoid this problem, the RX FIFO should never be emptied before the last byte of the packet is received.

For packet lengths less than 64 bytes it is recommended to wait until the complete packet has been received before reading it out of the RX FIFO.

If the packet length is larger than 64 bytes, the MCU must determine how many bytes can be read from the RX FIFO (RXBYTES.NUM_RXBYTES-1). The following software routine can be used:

- Read RXBYTES.NUM_RXBYTES
 repeatedly at a rate specified to be at least
 twice that of which RF bytes are received
 until the same value is returned twice; store
 value in n.
- If n < # of bytes remaining in packet, read n-1 bytes from the RX FIFO.
- 3. Repeat steps 1 and 2 until *n* = # of bytes remaining in packet.
- 4. Read the remaining bytes from the RX FIFO.

The 4-bit FIFOTHR.FIFO_THR setting is used to program threshold points in the FIFOs.

Table 28 lists the 16 FIFO_THR settings and the corresponding thresholds for the RX FIFO.

FIFO_THR	Bytes in RX
0 (0000)	4
1 (0001)	8
2 (0010)	12
3 (0011)	16
4 (0100)	20
5 (0101)	24
6 (0110)	28
7 (0111)	32
8 (1000)	36
9 (1001)	40
10 (1010)	44
11 (1011)	48
12 (1100)	52
13 (1101)	56
14 (1110)	60
15 (1111)	64

Table 27: FIFO_THR Settings and the Corresponding RX FIFO Thresholds

A signal will assert when the number of bytes in the RX FIFO is equal to or higher than the programmed threshold. This signal can be viewed on the GDO pins (see Table 29 on page 42).

Figure 24 shows the number of bytes in the RX FIFO when the threshold signal toggles in the case of FIFO_THR=13. Figure 25 shows the signal on the GDO pin as the RX FIFO is filled above the threshold, and then drained below in the case of FIFO THR=13.

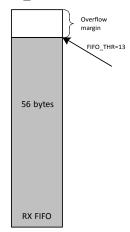


Figure 21: Example of RX FIFO at Threshold



Figure 22: Number of Bytes in RX FIFO vs.

the GDO Signal
(GDOx CFG=0x00 and FIFO THR=13)

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20 Frequency Programming

The frequency programming in **HC210M-R** is designed to minimize the programming needed when changing frequency.

To set up a system with channel numbers, the desired channel spacing is programmed with the MDMCFG0.CHANSPC M and MDMCFG1.CHANSPC E registers. The channel spacing registers are mantissa and exponent

respectively. The base or start frequency is set

by the 24 bit frequency word located in the FREQ2, FREQ1, and FREQ0 registers. This word will typically be set to the centre of the lowest channel frequency that is to be used.

The desired channel number is programmed with the 8-bit channel number register, CHANNR.CHAN, which is multiplied by the channel offset. The resultant carrier frequency is given by:

$$f_{carrier} = \frac{f_{XOSC}}{2^{16}} \cdot (FREQ + CHAN \cdot ((256 + CHANSPC _M) \cdot 2^{CHANSPC_E-2}))$$

With a 26 MHz crystal the maximum channel spacing is 405 kHz. To get e.g. 1 MHz channel spacing, one solution is to use 333 kHz channel spacing and select each third channel in CHANNR.CHAN.

The preferred IF frequency is programmed with the FSCTRL1.FREQ IF register. frequency is given by:

$$f_{IF} = \frac{f_{XOSC}}{2^{10}} \cdot FREQ_IF$$

21 VCO

The VCO is completely integrated on-chip.

If any frequency programming register is altered when the frequency synthesizer is running, the synthesizer may give an undesired response. Hence, the frequency should only be updated when the radio is in the IDLE state

21.1 VCO and PLL Self-Calibration

The VCO characteristics vary with temperature and supply voltage changes as well as the desired operating frequency. In order to ensure reliable HC210M-R operation, includes frequency synthesizer self-calibration circuitry. This calibration should be done regularly, and must be performed after turning on power and before using a new frequency (or channel). The number of XOSC cycles for completing the PLL calibration is given in Table 26 on page 38.

The calibration can be initiated automatically or manually. The synthesizer can be automatically calibrated each time the synthesizer is turned on, or each time the synthesizer is turned off automatically. This is configured with the MCSMO.FS AUTOCAL register setting. In manual mode, the calibration is initiated when the SCAL command strobe is activated in the IDLE mode.

Note: The calibration values are maintained in SLEEP mode, so the calibration is still valid after waking up from SLEEP mode unless supply voltage or temperature has changed significantly.

To check that the PLL is in lock, the user can program register IOCFGx.GDOx_CFG to 0x0A, and use the lock detector output available on the GDOx pin as an interrupt for the MCU (x = 0,1, or 2). A positive transition on the GDOx pin means that the PLL is in lock. As an alternative the user can read register FSCAL1. The PLL is in lock if the register content is different from 0x3F. Refer also to the **HC210M-R** Errata Notes [3].

For more robust operation, the source code could include a check so that the PLL is recalibrated until PLL lock is achieved if the PLL does not lock the first time.

22 Voltage Regulators

HC210M-R contains several on-chip linear voltage regulators that generate the supply voltages needed by low-voltage modules. These voltage regulators are invisible to the user, and

can be viewed as integral parts of the various modules. The user must however make sure that the absolute maximum ratings and

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required pin voltages in Table 1 and Table 12 are not exceeded.

By setting the CSn pin low, the voltage regulator to the digital core turns on and the crystal oscillator starts. The SO pin on the SPI interface must go low before the first positive edge of SCLK (setup time is given in Table 15).

If the chip is programmed to enter power-down mode (SPWD strobe issued), the power will be turned off after CSn goes high. The power and crystal oscillator will be turned on again when CSn goes low.

The voltage regulator for the digital core requires one external decoupling capacitor.

The voltage regulator output should only be used for driving the **C113L**.

23 General Purpose / Test Output Control Pins

The three digital output pins GDO0, GDO1, and GDO2 are general control pins configured with IOCFG0.GDO0 CFG,

IOCFG1.GDO1_CFG, and IOCFG2.GDO2_CFG respectively. Table 29 shows the different signals that can be monitored on the GDO pins. These signals can be used as inputs to the MCU.

GDO1 is the same pin as the SO pin on the SPI interface, thus the output programmed on this pin will only be valid when CSn is high. The default value for GDO1 is 3-stated which is useful when the SPI interface is shared with other devices.

The default value for GDO0 is a 135 - 141 kHz clock output (XOSC frequency divided by 192). Since the XOSC is turned on

at power-on-reset, this can be used to clock the MCU in systems with only one crystal. When the MCU is up and running, it can change the clock frequency by writing to IOCFGO.GDOO CFG.

If the <code>IOCFGx.GDOx_CFG</code> setting is less than 0x20 and <code>IOCFGx_GDOx_INV</code> is 0 (1), the GDO0 and GDO2 pins will be hardwired to 0 (1), and the GDO1 pin will be hardwired to 1 (0) in the SLEEP state. These signals will be hardwired until the <code>CHIP RDYn</code> signal goes low.

If the ${\tt IOCFGx.GDOx_CFG}$ setting is ${\tt 0x20}$ or higher, the GDO pins will work as programmed also in SLEEP state. As an example, GDO1 is high impedance in all states if ${\tt IOCFG1.GDO1\ CFG=0x2E}$.

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Table 28: GDOx Signal Selection (x = 0, 1, or 2)

GDOx_CFG[5:0]	Description								
0 (0x00)		e RX FIFO: Asserts when RX FIFO is filled at or above the RX FIFO sserts when RX FIFO is drained below the same threshold.							
1 (0x01)	Associated to the threshold or the	e RX FIFO: Asserts when RX FIFO is filled at or above the RX FIFO end of packet is reached. De-asserts when the RX FIFO is empty.							
2 (0x02) - 3 (0x03)		Reserved - used for test.							
4 (0x04)	Asserts when the	RX FIFO has overflowed. De-asserts when the FIFO has been flushed.							
5 (0x05)	Reserved - used	for test.							
6 (0x06) 7 (0x07)	pin will also de- filtering or when to Asserts when a re	Asserts when sync word has been received, and de-asserts at the end of the packet. The pin will also de-assert when a packet is discarded due to address or maximum length filtering or when the radio enters RXFIFO OVERFLOW state. Asserts when a packet has been received with CRC OK. De-asserts when the first byte							
8 (0x08) - 9 (0x09)	is read from the Reserved - used								
10 (0x0A)	Lock detector out	tput. The PLL is in lock if the lock detector output has a positive transition logic high. To check for PLL lock the lock detector output should be used							
11 (0x0B)	as an interrupt for Serial Clock Svi	or the MCU.							
10 (0.00)		tet up on the falling edge by #C210M-R when							
12 (0x0C)	•	ous Data Output. Used for synchronous serial mode.							
13 (0x0D)	•	ut. Used for asynchronous serial mode.							
14 (0x0E)		gh if RSSI level is above threshold. Cleared when entering IDLE mode.							
15 (0x0F)		st CRC comparison matched. Cleared when entering/restarting RX mode.							
16 (0x10) - 27 (0x1B)	Reserved - used								
28 (0x1C)	LNA_PD. Note: LNA_PD will have the same signal level in SLEEP and RX states. To control an external LNA in applications where the SLEEP state is used it is recommended to use GDOx CFGx=0x2F instead.								
29 (0x1D) - 38 (0x26)	Reserved - used for test.								
39 (0x27)	CLK_32k.								
40 (0x28)	Reserved - used	for test.							
41 (0x29)	CHIP_RDYn.								
42 (0x2A)	Reserved - used	for test.							
43 (0x2B)	XOSC_STABLE.								
44 (0x2C) - 45 (0x2D)	Reserved - used	for test.							
46 (0x2E)	High impedance	(3-state).							
47 (0x2F)	HW to 0 (HW1 ad	chieved by setting GDOx INV=1). Can be used to control an external LNA							
48 (0x30)	CLK_XOSC/1	Note: There are 3 GDO pins, but only one CLK_XOSC/n can be							
49 (0x31)	CLK_XOSC/1.5	selected as an output at any time. If CLK_XOSC/n is to be monitored							
50 (0x32)	CLK_XOSC/2	on one of the GDO pins, the other two GDO pins must be configured							
51 (0x33)	CLK_XOSC/3	to values less than 0x30. The GDO0 default value is CLK_XOSC/192.							
52 (0x34)	CLK_XOSC/4	To optimize RF performance, these signals should not be used while the							
53 (0x35)	CLK_XOSC/6	radio is in RX mode.							
54 (0x36)	CLK_XOSC/8								
55 (0x37)	CLK_XOSC/12								
56 (0x38)	CLK_XOSC/16								
57 (0x39)	CLK_XOSC/24								
58 (0x3A)	CLK_XOSC/32								
59 (0x3B)	CLK_XOSC/48								
60 (0x3C)	CLK_XOSC/64								
61 (0x3D)	CLK_XOSC/96								
62 (0x3E)	CLK_XOSC/128								
63 (0x3F)	CLK_XOSC/192								



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24 Asynchronous and Synchronous Serial Operation

Several features and modes of operation have been included in the **#C210M-R** to provide backward compatibility with previous Chipcon products and other existing RF communication systems. For new systems, it is recommended

to use the built-in packet handling features, as they can give more robust communication, significantly offload the microcontroller, and simplify software development.

24.1 Asynchronous Serial Operation

Asynchronous transfer is included in the **#C210M- f** for backward compatibility with systems that are already using the asynchronous data transfer.

When asynchronous transfer is enabled, all packet handling support is disabled and it is not possible to use Manchester encoding.

Asynchronous serial mode is enabled by setting PKTCTRL0.PKT_FORMAT to 3. Data output can be on GDO0, GDO1, or GDO2. This is set by the <code>IOCFG0.GDO0_CFG</code>, <code>IOCFG1.GDO1_CFG</code> and <code>IOCFG2.GDO2_CFG</code> fields.

In asynchronous serial mode no data decision is done on-chip and the raw data is put on the data output line. When using asynchronous serial mode make sure the interfacing MCU

does proper oversampling and that it can handle the jitter on the data output line. The MCU should tolerate a jitter of ±1/8 of a bit period as the data stream is time-discrete using 8 samples per bit.

In asynchronous serial mode there will be glitches of 37 - 38.5 ns duration (1/XOSC) occurring infrequently and with random periods. A simple RC filter can be added to the data output line between HG210M-B and the MCU to get rid of the 37 - 38.5 ns glitches if considered a problem. The filter 3 dB cut-off frequency needs to be high enough so that the data is not filtered and at the same time low enough to remove the glitch. As an example, for 2.4 kBaud data rate a 1 $k\Omega$ resistor and

2.7 nF capacitor can be used. This gives a 3 dB cut-off frequency of 59 kHz.

24.2 Synchronous Serial Operation

Setting PKTCTRLO.PKT_FORMAT to 1 enables synchronous serial mode. When using this mode, sync detection should be disabled together with CRC calculation (MDMCFG2.SYNC_MODE=000 and

In synchronous serial mode, data is transferred on a two-wire serial interface. The

HC210M-R provides a clock that is used to sample data on the data output line. The data output pin can be any of the GDO pins. This is set by the IOCFG0.GDO0 CFG,

IOCFG1.GD01_CFG, and IOCFG2.GD02_CFG fields. The RX latency is 9 bits.

The MCU must handle preamble and sync word detection in software, together with CRC calculation.

25 System Considerations and Guidelines

25.1 SRD Regulations

International regulations and national laws regulate the use of radio receivers and transmitters. Short Range Devices (SRDs) for license free operation below 1 GHz are usually operated in the 315 MHz, 433 MHz, 868 MHz or 915 MHz frequency bands. The **#C210M-R** is specifically designed for such use with its 300 - 348 MHz, 387 - 464 MHz, and

779 - 928 MHz operating ranges. The most important regulations when using the **#C210M-R** in the 315 MHz, 433 MHz, 868 MHz, or 915 MHz frequency bands are EN 300 220 V2.3.1 (Europe) and FCC CFR47 part 15 (USA).

For compliance with modulation bandwidth requirements under EN 300 220 V2.3.1 in the 863 to 870 MHz frequency range it is recommended to use a 26 MHz crystal for frequencies below 869 MHz and a 27 MHz crystal for frequencies above 869 MHz.

Please note that compliance with regulations is dependent on the complete system performance. It is the customer sresponsibility to ensure that the system complies with regulations.

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25.2 Calibration in Multi-Channel Systems

HC210M-T is highly suited for multi-channel systems due to its agile frequency synthesizer and effective communication interface.

Charge pump current, VCO current, and VCO capacitance array calibration data is required for each frequency when implementing a multi- channel system. There are 3 ways of obtaining the calibration data from the chip:

- 1) Calibration for every frequency change. The PLL calibration time is 712/724 μs (26 MHz crystal and TEST0 = 0x09/0B, see Table 27). The blanking interval between each frequency is then 787/799 μs .
- 2) Perform all necessary calibration at startup and store the resulting FSCAL3, FSCAL2, and FSCAL1 register values in MCU memory. The VCO capacitance calibration FSCAL1 register value must be found for each RF frequency to be used. The VCO current calibration value and the charge pump current calibration value available in FSCAL2 and FSCAL3 respectively are not dependent on the RF frequency, so the same value can therefore be used for all RF frequencies for these two registers. Between each frequency change, the calibration process can then be replaced by writing the FSCAL3, FSCAL2 and FSCAL1 register values that corresponds to the next RF frequency. The PLL turn on time is approximately 75 µs (Table 26). The blanking interval between each frequency hop is approximately 75 µs.
- 3) Run calibration on a single frequency at startup. Next write 0 to FSCAL3[5:4] to

disable the charge pump calibration. After writing to <code>FSCAL3[5:4]</code>, strobe <code>SRX</code> with <code>MCSMO.FS_AUTOCAL=1</code> for each new frequency. That is, VCO current and VCO capacitance calibration is done, but not charge pump current calibration. When charge pump current calibration is disabled the calibration time is reduced from 712/724 μs to 145/157 μs (26 MHz crystal and <code>TESTO = 0x09/0B</code>, see Table 27). The blanking interval between each frequency hop is then 220/232 μs .

There is a trade-off between blanking time and memory space needed for storing calibration data in non-volatile memory. Solution 2) above gives the shortest blanking interval, but requires more memory space to store calibration values. This solution also requires that the supply voltage and temperature do not vary much in order to have a robust solution. Solution 3) gives 567 µs smaller blanking interval than solution 1).

The recommended settings for TESTO.VCO_SEL_CAL_EN change with frequency. This means that one should always use SmartRF Studio [4] to get the correct settings for a specific frequency before doing a calibration, regardless of which calibration method is being used.

Note: The content in the TESTO register is not retained in SLEEP state, thus it is necessary to re-write this register when returning from the SLEEP state.

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26 Configuration Registers

The configuration of **HC210M-R** is done by programming 8-bit registers. The optimum configuration data based on selected system parameters are most easily found by using the SmartRF Studio software [4]. Complete descriptions of the registers are given in the following tables. After chip reset, all the registers have default values as shown in the tables. The optimum register setting might differ from the default value. After a reset, all registers that shall be different from the default value therefore needs to be programmed through the SPI interface.

There are 8 command strobe registers, listed in Table 30. Accessing these registers will initiate the change of an internal state or mode. There are 43 normal 8-bit configuration registers listed in Table 31, and SmartRF Studio [4] will provide recommended settings

for these registers².

² Addresses marked as "Not Used" can be part of a burst access and one can write a dummy value

to them. Addresses marked as

There are also 8 status registers that are listed in Table 32. These registers, which are read-only, contain information about the status of **#6210M-R**.

The RX FIFO is accessed through one 8-bit register. During the header byte transfer and while writing data to a register, a status byte is returned on the SO line. This status byte is described in Table 16 on page 23.

Table 33 summarizes the SPI address space. The address to use is given by adding the base address to the left and the burst and read/write bits on the top. Note that the burst bit has different meaning for base addresses above and below 0x2F.

"Reserved" must be configured according to SmartRF Studio

Table 29: Command Strobes

Address	Strobe Name	Description
0x30	SRES	Reset chip.
0x31	Reserved	
0x32	SXOFF	Turn off crystal oscillator.
0x33	SCAL	Calibrate frequency synthesizer and turn it off. SCAL can be strobed from IDLE mode without setting manual calibration mode
0x34	SRX	In IDLE state: Enable RX. Perform calibration first if MCSM0.FS_AUTOCAL=1.
0x35	Reserved	
0x36	SIDLE	Enter IDLE state
0x37 - 0x38	Reserved	
0x39	SPWD	Enter power down mode when CSn goes high.
0x3A	SFRX	Flush the RX FIFO buffer. Only issue SFRX in IDLE or RXFIFO_OVERFLOW
0x3B - 0x3C	Reserved	
0x3D	SNOP	No operation. May be used to get access to the chip status byte.

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Table 30: Configuration Registers Overview

Address	Register	Description	Preserved in SLEEP State	Details on Page
0x00	IOCFG2	GDO2 output pin configuration	Yes	49
0x01	IOCFG1	GDO1 output pin configuration	Yes	49
0x02	IOCFG0	GD00 output pin configuration	Yes	49
0x03	FIFOTHR	RX FIFO threshold	Yes	50
0x04	SYNC1	Sync word, high byte	Yes	51
0x05	SYNC0	Sync word, low byte	Yes	51
0x06	PKTLEN	Packet length	Yes	51
0x07	PKTCTRL1	Packet automation control	Yes	51
0x08	PKTCTRL0	Packet automation control	Yes	52
0x09	ADDR	Device address	Yes	52
0x0A	CHANNR	Channel number	Yes	52
0x0B	FSCTRL1	Frequency synthesizer control	Yes	52
0x0C	FSCTRL0	Frequency synthesizer control	Yes	53
0x0D	FREQ2	Frequency control word, high byte	Yes	53
0x0E	FREQ1	Frequency control word, middle byte	Yes	53
0x0F	FREQ0	Frequency control word, low byte	Yes	53
0x10	MDMCFG4	Modem configuration	Yes	53
0x11	MDMCFG3	Modem configuration	Yes	53
0x12	MDMCFG2	Modem configuration	Yes	54
0x13	MDMCFG1	Modem configuration	Yes	55
0x14	MDMCFG0	Modem configuration	Yes	55
0x15	DEVIATN	Modem deviation setting	Yes	55
0x16	MCSM2	Main Radio Control State Machine	Yes	55
0x17	MCSM1	Main Radio Control State Machine	Yes	55
0x18	MCSM0	Main Radio Control State Machine	Yes	56
0x19	FOCCFG	Frequency Offset Compensation	Yes	57
0x1A	BSCFG	Bit Synchronization configuration	Yes	58
0x1B	AGCTRL2	AGC control	Yes	59
0x1C	AGCTRL1	AGC control	Yes	60
0x1D	AGCTRL0	AGC control	Yes	61
0x1E - 0x1F	Not Used			
0x20	RESERVED		Yes	61
0x21	FREND1	Front end RX configuration	Yes	62
0x22	Not Used			
0x23	FSCAL3	Frequency synthesizer calibration	Yes	62
0x24	FSCAL2	Frequency synthesizer calibration	Yes	62
0x25	FSCAL1	Frequency synthesizer calibration	Yes	62
0x26	FSCAL0	Frequency synthesizer calibration	Yes	62
0x27 - 0x28	Not Used			
0x29 - 0x2B	RESERVED		No	63
0x2C	TEST2	Various test settings	No	63
0x2D	TEST1	Various test settings	No	63
0x2E	TEST0	Various test settings	No	63



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Table 31: Status Registers Overview

Address	Register	Description	Details	on	page
0x30 (0xF0)	PARTNUM	Part number for <i>HC210M-R</i>	64		
0x31 (0xF1)	VERSION	Current version number	64		
0x32 (0xF2)	FREQEST	Frequency Offset Estimate	64		
0x33 (0xF3)	CRC_REG	CRC OK	64		
0x34 (0xF4)	RSSI	Received signal strength indication	64		
0x35 (0xF5)	MARCSTATE	Control state machine state	65		
0x36 - 0x37 (0xF6 - 0xF7)	Reserved				
0x38 (0xF8)	PKTSTATUS	Current GDOx status and packet status	66		
0x39 - 0x3A (0xF9 - 0xFA)	Reserved				
0x3B (0xFB)	RXBYTES	Overflow and number of bytes in the RX	66		
0x3C - 0x3D (0xFC -	Reserved				

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Table 32: SPI Address Space

	Wı	rite	Read							
	Single Byte	Burst	Single Byte	Burst						
	+0x00	+0x40	+0x80	+0xC0						
0x00			CFG2							
0x01			CFG1							
0x02			CFG0							
0x03		FIFOTHR								
0x04		SYNC1								
0x05		SYNC0								
0x06			KTLEN		o O					
0x07			TCTRL1		lqi					
0x08			TCTRL0		SSC					
0x09			ADDR		Ъ					
0x0A			HANNR		SS					
0x0B			CTRL1 CTRL0		SS					
0x0C			REQ2		ä					
0x0D 0x0E			REQ2 REQ1		ızt					
0x0E			REQ0		pn					
0x0F 0x10			MCFG4		δ,					
0x10			MCFG3		te					
0x11			MCFG2		gis					
0x12			MCFG1		<u> </u>					
0x14			MCFG0		R/W configuration registers, burst access possible					
0x15			VIATN		rat					
0x16		M	CSM2		gu					
0x17		M	CSM1		nfi					
0x18	MCSM0									
0x19	FOCCFG									
0x1A	BSCFG									
0x1B	AGCCTRL2									
0x1C	AGCCTRL1									
0x1D	AGCCTRL0									
0x1E	Not Used									
0x1F 0x20		Not Used RESERVED								
0x20 0x21			REND1							
0x21										
0x23		Not Used FSCAL3								
0x24		FSCAL2								
0x25	FSCAL2 FSCAL1									
0x26		FSCALI FSCALO								
0x27		No	ot Used							
0x28			ot Used							
0x29			SERVED							
0x2A			SERVED							
0x2B		RESERVED								
0x2C		TEST2								
0x2D		TEST1 TEST0								
0x2E 0x2F			ot Used							
0x2F 0x30	SRES	INC	SRES	PARTNUM						
0x30	Reserved		Reserved	VERSION						
0x32	SXOFF		SXOFF	FREQEST						
0x33	SCAL		SCAL	CRC_REG	<i>"</i> ≒					
0x34	SRX		SRX	RSSI	3,5					
0x35	Reserved		Reserved	MARCSTATE	gg					
0x36	SIDLE		SIDLE	Reserved	s, (
0x37	Reserved		Reserved	Reserved	ge_ge					
0x38	Reserved		Reserved	PKTSTATUS	5 2 2					
0x39	SPWD		SPWD	Reserved	Saga					
0x3A	SFRX		SFRX	Reserved	2,2,3					
0x3B	Reserved		Reserved	RXBYTES	Command Strobes, Status gisters (read only) and multi byte registers					
0x3C	Reserved		Reserved	Reserved	Ste 2					
0x3D	SNOP		SNOP	Reserved	Comma registers					
0x3E	Reserved		Reserved	Reserved	<u> </u>					
0x3F	Reserved		RX FIFO	RX FIFO						



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26.1 Configuration Register Details - Registers with preserved values in SLEEP state 0x00: IOCFG2 - GDO2 Output Pin Configuration

Bit	Field Name	Reset	R/W	Description
7			R0	Not used
6	GD02_INV	0	R/W	Invert output, i.e. select active low (1) / high (0)
5:0	GD02_CFG[5:0]	41 (101001)	R/W	Default is CHP_RDYn (See Table 29 on page 42).

0x01: IOCFG1 - GDO1 Output Pin Configuration

Bit	Field Name	Reset	R/W	Description
7	GDO_DS	0	R/W	Set high (1) or low (0) output drive strength on the GDO pins.
6	GD01_INV	0	R/W	Invert output, i.e. select active low (1) / high (0)
5:0	GD01_CFG[5:0]	46 (101110)	R/W	Default is 3-state (See Table 29 on page 42).

0x02: IOCFG0 - GDO0 Output Pin Configuration

Bit	Field Name	Reset	R/W	Description
7		0	R/W	Use setting from SmartRF Studio [4]
6	GDO0_INV	0	R/W	Invert output, i.e. select active low (1) / high (0)
5:0	GD00_CFG[5:0]	63 (0x3F)	R/W	Default is CLK_XOSC/192 (See Table 29 on page 42).
				It is recommended to disable the clock output in initialization, in order to optimize RF performance.

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0x03: FIFOTHR - RX FIFO Thresholds

Bit	Field Name	Reset	R/W	/ Description			
7		0	R/W	Use setting from SmartRF Studio [4]			
6	ADC_RETENTION	0	R/W	0: TEST1 = 0x31	and TEST2= 0x88 when waking up from		
				SLEEP 1: TEST1 = 0x35 and TEST2 = 0x81 when waking up			
				from SLEEP			
				Note that the changes in the TEST registers due to the ADC_RETENTION bit setting are only seen INTERNALLY in the analog part. The values read from the TEST registers when waking up from SLEEP mode will always be the reset value.			
				The ADC_RETENTION bit should be set to 1before going into SLEEP mode if settings with an RX filter bandwidth below 325 kHz are wanted at time of wake-up.			
5:4	CLOSE_IN_RX[1:0]	0 (00)	R/W	For more details, p	lease see DN010 [5]		
				Setting	RX Attenuation, Typical Values		
				0 (00)	0 dB		
				1 (01)	6 dB		
				2 (10)	12 dB		
				3 (11)	18 dB		
3:0	FIFO_THR[3:0]	7 (0111)	R/W	Set the threshold for the RX FIFO. The threshold is exceeded when the number of bytes in the RX FIFO is equal to or higher than the threshold value.			
				Setting	Bytes in RX FIFO		
				0 (0000)	4		
				1 (0001)	8		
				2 (0010)	12		
				3 (0011)	16		
				4 (0100)	20		
				5 (0101)	24		
				6 (0110)	28		
				7 (0111)	32		
				8 (1000)	36		
				9 (1001)	40		
				10 (1010)	44		
				11 (1011)	48		
				12 (1100)	52		
				13 (1101)	56		
				14 (1110)	60		
				15 (1111)	64		



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0x04: SYNC1 - Sync Word, High Byte

Bit	Field Name	Reset	R/W	Description
7:0	SYNC[15:8]	211 (0xD3)	R/W	8 MSB of 16-bit sync word

0x05: SYNC0 - Sync Word, Low Byte

Bit	Field Name	Reset	R/W	Description
7:0	SYNC[7:0]	145 (0x91)	R/W	8 LSB of 16-bit sync word

0x06: PKTLEN - Packet Length

Bit	Field Name	Reset	R/W	Description
7:0	PACKET_LENGTH	255 (0xFF)	R/W	Indicates the packet length when fixed packet length mode is enabled. If variable packet length mode is used, this value indicates the maximum packet length allowed. This value must be different from 0.

0x07: PKTCTRL1 - Packet Automation Control

Bit	Field Name	Reset	R/W	Description	on	
7:5		0 (000)	R/W	Use settin	g from SmartRF Studio [4]	
4		0	R0	Not Used.		
3	CRC_AUTOFLUSH	0	R/W	Enable automatic flush of RX FIFO when CRC is not OK. This requires that only one packet is in the RX FIFO and that packet length is limited to the RX FIFO size.		
2	APPEND_STATUS	1	R/W	When enabled, two status bytes will be appended to the payload of the packet. The status bytes contain the RSSI value, as well as CRC OK.		
1:0	ADR_CHK[1:0]	0 (00)	R/W	Controls address check configuration of received packages.		
				Setting	Address check configuration	
				0 (00)	No address check	
				1 (01)	Address check, no broadcast	
				2 (10)	Address check and 0 (0x00) broadcast	
				3 (11)	Address check and 0 (0x00) and 255 (0xFF) broadcast	

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0x08: PKTCTRL0 - Packet Automation Control

Bit	Field Name	Reset	R/W	Description	
7			R0	Not used	
6		1	R/W	Use setting f	rom SmartRF Studio [4]
5:4	PKT_FORMAT[1:0]	0 (00)	R/W	Format of R	X data
				Setting	Packet format
				0 (00)	Normal mode, use RX FIFO
				1 (01)	Synchronous serial mode, Data out on either of the GDOx pins
				2 (10)	Reserved
				3 (11)	Asynchronous serial mode, Data out on either of the GDOx pins
3		0	R0	Not used	
2	CRC_EN	1	R/W	1: CRC calcu	ulation enabled
				0: CRC calcu	ulation disabled
1:0	LENGTH_CONFIG[1:0]	1 (01)	R/W	Configure the	e packet length
				Setting	Packet length configuration
				0 (00)	Fixed packet length mode. Length configured in PKTLEN register
				1 (01)	Variable packet length mode. Packet length configured by the first byte received after sync word
				2 (10)	Infinite packet length mode
				3 (11)	Reserved

0x09: ADDR - Device Address

Bit	Field Name	Reset	R/W	Description
7:0	DEVICE_ADDR[7:0]	0 (0x00)	R/W	Address used for packet filtration. Optional broadcast addresses are 0 (0x00) and 255 (0xFF).

0x0A: CHANNR - Channel Number

Bit	Field Name	Reset	R/W	Description
7:0	CHAN[7:0]	0 (0x00)	R/W	The 8-bit unsigned channel number, which is multiplied by the channel spacing setting and added to the base frequency.

0x0B: FSCTRL1 - Frequency Synthesizer Control

Bit	Field Name	Reset	R/W	Description
7:6			R0	Not used
5		0	R/W	Use setting from SmartRF Studio [4]
4:0	FREQ_IF[4:0]	15 (01111)	R/W	The desired IF frequency to employ in RX. Subtracted from FS base frequency in RX and controls the digital complex mixer in the demodulator.
				$f_{IF} = \frac{f_{XOSC}}{2^{10}} \cdot FREQ_IF$
				The default value gives an IF frequency of 381kHz, assuming a 26.0 MHz crystal.

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0x0C: FSCTRL0 - Frequency Synthesizer Control

Bit	Field Name	Reset	R/W	Description
7:0	FREQOFF[7:0]	0 (0x00)	R/W Frequency offset added to the base frequency before being the frequency synthesizer. (2s-complement).	
				Resolution is $F_{xTAL}/2^{14}$ (1.59 kHz - 1.65kHz); range is ±202 kHz to ±210 kHz, dependent of XTAL frequency.

0x0D: FREQ2 - Frequency Control Word, High Byte

Bit	Field Name	Reset	R/W	Description
7:6	FREQ[23:22]	0 (00)	R	FREQ[23:22] is always 0 (the FREQ2 register is less than 36 with 26 - 27 MHz crystal)
5:0	FREQ[21:16]	30 (011110)	R/W	FREQ[23:0] is the base frequency for the frequency synthesiser in increments of $f_{xosc}/2^{16}$. $f_{carrier} = \frac{f_{xosc}}{2^{16}} \cdot FREQ[23:0]$

0x0E: FREQ1 - Frequency Control Word, Middle Byte

Bit	Field Name	Reset	R/W	Description
7:0	FREQ[15:8]	196 (0xC4)	R/W	Ref. FREQ2 register

0x0F: FREQ0 - Frequency Control Word, Low Byte

Bit	Field Name	Reset	R/W	Description
7:0	FREQ[7:0]	236 (0xEC)	R/W	Ref. FREQ2 register

0x10: MDMCFG4 - Modem Configuration

Bit	Field Name	Reset	R/W	Description	
7:6	CHANBW_E[1:0]	2 (10)	R/W		
5:4	CHANBW_M[1:0]	0 (00)	R/W	Sets the decimation ratio for the delta-sigma ADC input stream and thus the channel bandwidth.	
				$BW_{channel} = \frac{f_{XOSC}}{8 \cdot (4 + CHANBW_M) \cdot 2^{CHANBW_E}}$	
				The default values give 203 kHz channel filter bandwidth, assuming a 26.0 MHz crystal.	
3:0	DRATE_E[3:0]	12 (1100)	R/W	The exponent of the user specified symbol rate	

0x11: MDMCFG3 - Modem Configuration

Bit	Field Name	Reset	R/W	Description
7:0	DRATE_M[7:0]	34 (0x22)	R/W	The mantissa of the user specified symbol rate. The symbol rate is configured using an unsigned, floating-point number with 9-bit mantissa and 4-bit exponent. The 9 th bit is a hidden "1". The resulting data rate is:
				$R_{DATA} = \frac{(256 + RATE_M) \cdot 2^{DRATE_E}}{2^{28}} \cdot f_{XOSC}$
				The default values give a data rate of 115.051 kBaud (closest setting to 115.2 kBaud), assuming a 26.0 MHz crystal.

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0x12: MDMCFG2 - Modem Configuration

Bit	Field Name	Reset	R/W	Description	n	
7	DEM_DCFILT_OFF	0	R/W	Disable dig	ital DC blocking filter before demodulator.	
				0 = Enable	(better sensitivity)	
				1 = Disable	(current optimized). Only for data rates ≤ 250 kBaud	
				The recommended IF frequency changes when the DC blocking is disable Please use SmartRF Studio [4] to calculate correct register setting.		
6:4	MOD_FORMAT[2:0]	0 (000)	R/W	The modulation format of the radio signal		
				Setting	Modulation format	
				0 (000)	2-FSK	
				1 (001)	GFSK	
				2 (010)	Reserved	
				3 (011)	ООК	
				4 (100)	4-FSK	
				5 (101)	Reserved	
				6 (110)	Reserved	
				7 (111)	Reserved	
				4-FSK modulation cannot be used together with Manchester encoding		
3	MANCHESTER_EN	0	R/W	Enables Manchester decoding. 0 =		
				Disable		
				1 = Enable		
					encoding cannot be used when using asynchronous serial FSK modulation	
2:0	SYNC_MODE[2:0]	2 (010)	R/W	Combined s	sync-word qualifier mode.	
				The values	0 and 4 disables preamble and sync word detection	
				bits need to	1, 2, 5, and 6 enables 16-bit sync word detection. Only 15 of 16 o match when using setting 1 or 5. The values 3 and 7 enables word detection (only 30 of 32 bits need to match). Sync-word qualifier mode	
				0 (000)	No preamble/sync	
				1 (001)	15/16 sync word bits detected	
				2 (010)	16/16 sync word bits detected	
				3 (011)	30/32 sync word bits detected	
				4 (100)	No preamble/sync, carrier-sense above threshold	
				5 (101)	15/16 + carrier-sense above threshold	
				6 (110)	16/16 + carrier-sense above threshold	
				7 (111)	30/32 + carrier-sense above threshold	

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0x13: MDMCFG1 - Modem Configuration

Bit	Field Name	Reset	R/W Description	
7		0	R/W	Use setting from SmartRF Studio [4]
6:2			R0	Not used
1:0	CHANSPC_E[1:0]	2 (10)	R/W	2 bit exponent of channel spacing

0x14: MDMCFG0 - Modem Configuration

Bit	Field Name	Reset	R/W	Description
7:0	CHANSPC_M[7:0]	248 (0xF8)	R/W	8-bit mantissa of channel spacing. The channel spacing is multiplied by the channel number CHAN and added to the base frequency. It is unsigned and has the format: $\Delta f_{CHANNEL} = \frac{f_{XOSC}}{2^{18}} \cdot (256 + CHANSPC_M) \cdot 2^{CHANSPC_E}$ The default values give 199.951 kHz channel spacing (the closest setting to 200 kHz), assuming 26.0 MHz crystal frequency.

0x15: DEVIATN - Modem Deviation Setting

Bit	Field Name	Reset	R/W	Description		
7			R0	Not used.	Not used.	
6:4	DEVIATION_E[2:0]	4 (100)	R/W	Deviation exponent.		
3			R0	Not used.		
2:0	DEVIATION_M[2:0]	7 (111)	R/W	2-FSK/ GFSK/ 4-FSK	Specifies the expected frequency deviation of incoming signal, must be approximately right for demodulation to be performed reliably and robustly.	
				ООК	This setting has no effect.	

0x16: MCSM2 - Main Radio Control State Machine Configuration

Bit	Field Name	Reset	R/W	Description
7:5			R0	Not used
4	RX_TIME_RSSI	0	R/W	Direct RX termination based on RSSI measurement (carrier sense). For OOK modulation, RX times out if there is no carrier sense in the first 8 symbol periods.
3:0		7 (0111)	R/W	Use setting from SmartRF Studio [4]

0x17: MCSM1 - Main Radio Control State Machine Configuration

Bit	Field Name	Reset	R/W	Description	
7:6			R0	Not used	
5:4		3 (11)	R/W	Use setting from SmartRF Studio [4]	
3:2	RXOFF_MODE[1:0]	0 (00)	R/W	Select what should happen when a packet has been received.	
				Setting Next state after finishing packet reception	
				0 (00) IDLE	
				1 (01) Reserved	
				2 (10) Reserved	
				3 (11) Stay in RX	
1:0		0 (00)	R/W	Use setting from SmartRF Studio [4]	

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0x18: MCSM0 - Main Radio Control State Machine Configuration

Bit	Field Name	Reset	R/W	Description	Description		
7:6			R0	Not used			
5:4	FS_AUTOCAL[1:0]	0 (00)	R/W	Automatica	lly calibrate when	going to to/from RX mode	
				Setting	When to perform	n automatic calibration	
				0 (00)	Never (manually	y calibrate using SCAL strobe)	
				1 (01)	When going from	m IDLE to RX	
				2 (10)	When going from	m RX back to IDLE automatically	
				3 (11)	Every 4 th time automatically	when going from RX to IDLE	
3:2	PO_TIMEOUT	1 (01)	R/W		Programs the number of times the six-bit ripple counter mu expire after the XOSC has settled before CHP_RDYn goes low. ³		
				If XOSC is on (stable) during power-down, PO_TIMEOUT shall be set so that the regulated digital supply voltage has time to stabilize before CHP_RDYn goes low (PO_TIMEOUT=2 recommended). Typical start-up time for the voltage regulator is 50 µs.			
					operation it is rec	ommended to use $PO_TIMEOUT = 2$ g power-down.	
				Setting	Expire count	Timeout after XOSC start	
				0 (00)	1	Approx. 2.3 - 2.4 μs	
				1 (01)	16	Approx. 37 - 39 μs	
				2 (10)	64	Approx. 149 - 155 μs	
				3 (11)	256	Approx. 597 - 620 μs	
				Exact timed	out depends on cr	ystal frequency.	
1		0	R/W	Use setting	Use setting from SmartRF Studio [4]		
0	XOSC_FORCE_ON	0	R/W	Force the X	OSC to stay on ir	the SLEEP state.	

³ Note that the XOSC_STABLE signal will be asserted at the same time as the CHIP_RDYn signal; i.e. the PO_TIMEOUT delays both signals and does not insert a delay between the signals.

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0x19: FOCCFG - Frequency Offset Compensation Configuration

Bit	Field Name	Reset	R/W	Description	Description			
7:6			R0	Not used				
5	FOC_BS_CS_GATE	1	R/W		If set, the demodulator freezes the frequency offset compensation and clock recovery feedback loops until the CS signal goes high.			
4:3	FOC_PRE_K[1:0]	2 (10)	R/W	The frequency compensation loop gain to be used before a sync word detected.				
				Setting	Freq. compensation loop gain before sync word			
				0 (00)	К			
				1 (01)	2K			
				2 (10)	3 <i>K</i>			
				3 (11)	4K			
2	FOC_POST_K	1	R/W	The frequen	cy compensation loop gain to be used after a sync word is detected.			
				Setting	Freq. compensation loop gain after sync word			
				0	Same as FOC_PRE_K			
				1	K/2			
1:0	FOC_LIMIT[1:0]	2 (10)	R/W	The saturation	on point for the frequency offset compensation algorithm:			
				Setting	Saturation point (max compensated offset)			
				0 (00)	±0 (no frequency offset compensation)			
				1 (01)	±BW _{CHAN} /8			
				2 (10)	±BW _{CHAN} /4			
				3 (11)	±BW _{CHAN} /2			
					offset compensation is not supported for OOK. Always IMIT=0 with this modulation format.			



0x1A: BSCFG - Bit Synchronization Configuration

Bit	Field Name	Reset	R/W	Descripti	Description		
7:6	BS_PRE_KI[1:0]	1 (01)	R/W		recovery feedback loop integral gain to be used before a syncletected (used to correct offsets in data rate):		
				Setting	Clock recovery loop integral gain before sync word		
				0 (00)	K,		
				1 (01)	2 <i>K</i> ,		
				2 (10)	3 <i>K</i> ₁		
				3 (11)	4 <i>K</i> ₁		
5:4	BS_PRE_KP[1:0]	2 (10)	R/W		recovery feedback loop proportional gain to be used before ord is detected.		
				Setting	Clock recovery loop proportional gain before sync word		
				0 (00)	K_P		
				1 (01)	2 <i>K</i> _P		
				2 (10)	3₭₽		
				3 (11)	4 <i>K</i> _₽		
3	BS_POST_KI	1	R/W	The clock recovery feedback loop integral gain to be used after a syr word is detected.			
				Setting	Clock recovery loop integral gain after sync word		
				0	Same as BS_PRE_KI		
				1	K ₁ /2		
2	BS_POST_KP	1	R/W		recovery feedback loop proportional gain to be used after a dis detected.		
				Setting	Clock recovery loop proportional gain after sync word		
				0	Same as BS_PRE_KP		
				1	K_{P}		
1:0	BS_LIMIT[1:0]	0 (00)	R/W	The satur	ation point for the data rate offset compensation algorithm:		
				Setting	Data rate offset saturation (max data rate difference)		
				0 (00)	±0 (No data rate offset compensation performed)		
				1 (01)	±3.125 % data rate offset		
				2 (10)	±6.25 % data rate offset		
				3 (11)	±12.5 % data rate offset		

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0x1B: AGCCTRL2 - AGC Control

Bit	Field Name	Reset	R/W	Descripti	on		
7:6	MAX_DVGA_GAIN[1:	0 (00)	R/W	Reduces	Reduces the maximum allowable DVGA gain.		
	0]			Setting	Allowable DVGA settings		
				0 (00)	All gain settings can be used		
				1 (01)	The highest gain setting cannot be used		
				2 (10)	The 2 highest gain settings cannot be used		
				3 (11)	The 3 highest gain settings cannot be used		
5:3	MAX_LNA_GAIN[2:0]	0 (000)	R/W	Sets the maximum	maximum allowable LNA + LNA 2 gain relative to the possible gain.		
				Setting	Maximum allowable LNA + LNA 2 gain		
				0 (000)	Maximum possible LNA + LNA 2 gain		
				1 (001)	Approx. 2.6 dB below maximum possible gain		
				2 (010)	Approx. 6.1 dB below maximum possible gain		
				3 (011)	Approx. 7.4 dB below maximum possible gain		
				4 (100)	Approx. 9.2 dB below maximum possible gain		
				5 (101)	Approx. 11.5 dB below maximum possible gain		
				6 (110)	Approx. 14.6 dB below maximum possible gain		
				7 (111)	Approx. 17.1 dB below maximum possible gain		
2:0	MAGN_TARGET[2:0]	3 (011)	R/W		s set the target value for the averaged amplitude from the annel filter (1 LSB = 0 dB).		
				Setting	Target amplitude from channel filter		
				0 (000)	24 dB		
				1 (001)	27 dB		
				2 (010)	30 dB		
				3 (011)	33 dB		
				4 (100)	36 dB		
				5 (101)	38 dB		
				6 (110)	40 dB		
				7 (111)	42 dB		

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0x1C: AGCCTRL1 - AGC Control

Bit	Field Name	Reset	R/W	Descriptio	n
7			R0	Not used	
6	AGC_LNA_PRIORITY	1	R/W	gain adjust	tween two different strategies for LNA and LNA 2 ment. When 1, the LNA gain is decreased first. he LNA 2 gain is decreased to minimum before LNA gain.
5:4	CARRIER_SENSE_REL_THR[1:0]	0 (00)	R/W	Sets the re	lative change threshold for asserting carrier sense
				Setting	Carrier sense relative threshold
				0 (00)	Relative carrier sense threshold disabled
				1 (01)	6 dB increase in RSSI value
				2 (10)	10 dB increase in RSSI value
				3 (11)	14 dB increase in RSSI value
3:0	3:0 CARRIER_SENSE_ABS_THR[3:0])) R/W	The 2-com	psolute RSSI threshold for asserting carrier sense. plement signed threshold is programmed in steps d is relative to the MAGN_TARGET setting.
				Setting	Carrier sense absolute threshold
					(Equal to channel filter amplitude when AGC has not decreased gain)
				-8 (1000)	Absolute carrier sense threshold disabled
				-7 (1001)	7 dB below MAGN_TARGET setting
				•••	
				-1 (1111)	1 dB below MAGN_TARGET setting
				0 (0000)	At MAGN_TARGET setting
				1 (0001)	1 dB above MAGN_TARGET setting
				7 (0111)	7 dB above MAGN_TARGET setting

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0x1D: AGCCTRL0 - AGC Control

Bit	Field Name	Reset	R/W	Descript	ion	
7:6	HYST_LEVEL[1:0]	2 (10)	R/W		level of hysteresis on hal that determine gain of	the magnitude deviation (internal changes).
				Setting	Description	
				0 (00)	No hysteresis, small s	ymmetric dead zone, high gain
				1 (01)	Low hysteresis, smal	ll asymmetric dead zone, medium
				2 (10)	Medium hysteresis, medium gain	medium asymmetric dead zone,
				3 (11)	Large hysteresis, large	e asymmetric dead zone, low gain
5:4	WAIT_TIME[1:0]	1 (01)	R/W			r samples from a gain adjustment algorithm starts accumulating new
				Setting	Channel filter samples	3
				0 (00)	8	
				1 (01)	16	
				2 (10)	24	
				3 (11)	32	
3:2	AGC_FREEZE[1:0]	0 (00)	R/W	Control w	hen the AGC gain shou	ld be frozen.
				Setting	Function	
				0 (00)	Normal operation. Alw	ays adjust gain when required.
				1 (01)	The gain setting is fr found.	ozen when a sync word has been
				2 (10)	Manually freeze the a to adjust the digital ga	analogue gain setting and continue in.
				3 (11)		n the analogue and the digital gain ually overriding the gain.
1:0	FILTER_LENGTH[1:0]	1 (01)	R/W	2-FSK an		aging length for the amplitude from
				OOK: Set	ts the OOK decision bou	undary for OOK reception.
				Setting	Channel filter	OOK decision boundary
				0 (00)	8	4 dB
				1 (01)	16	8 dB
				2 (10)	32	12 dB
				3 (11)	64	16 dB

0x20: RESERVED

Bit	Field Name	Reset	R/W	Description
7:3		31 (11111)	R/W	Use setting from SmartRF Studio [4]
2			R0	Not used
1:0		0 (00)	R/W	Use setting from SmartRF Studio [4]



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0x21: FREND1 - Front End RX Configuration

Bit	Field Name	Reset	R/W	Description
7:6	LNA_CURRENT[1:0]	1 (01)	R/W	Adjusts front-end LNA PTAT current output
5:4	LNA2MIX_CURRENT[1:0]	1 (01)	R/W	Adjusts front-end PTAT outputs
3:2	LODIV_BUF_CURRENT_RX[1:	1 (01)	R/W	Adjusts current in RX LO buffer (LO input to mixer)
1:0	MIX_CURRENT[1:0]	2 (10)	R/W	Adjusts current in mixer

0x23: FSCAL3 - Frequency Synthesizer Calibration

Bit	Field Name	Reset	R/W	Description
7:6	FSCAL3[7:6]	2 (10)	R/W	Frequency synthesizer calibration configuration. The value to write in this field before calibration is given by the SmartRF Studio software [4].
5:4	CHP_CURR_CAL_EN[1:0]	2 (10)	R/W	Disable charge pump calibration stage when 0.
3:0	FSCAL3[3:0]	9 (1001)	R/W	Frequency synthesizer calibration result register. Digital bit vector defining the charge pump output current, on an exponential scale: $I_{0}UT = I_{0} \cdot 2^{SSOAL3(3:0)/4}$

0x24: FSCAL2 - Frequency Synthesizer Calibration

Bit	Field Name	Reset	R/W	Description
7:6			R0	Not used
5	VCO_CORE_H_EN	0	R/W	Choose high (1) / low (0) VCO
4:0	FSCAL2[4:0]	10 (01010)	R/W	Frequency synthesizer calibration result register. VCO current calibration result and override value. Please see Section 25.2 for more details.

0x25: FSCAL1 - Frequency Synthesizer Calibration

Bit	Field Name	Reset	R/W	Description
7:6			R0	Not used
5:0	FSCAL1[5:0]	32 (0x20)	R/W	Frequency synthesizer calibration result register. Capacitor array setting for VCO coarse tuning. Please see Section 25.2 for more details.

0x26: FSCAL0 - Frequency Synthesizer Calibration

Bit	Field Name	Reset	R/W	Description
7			R0	Not used
6:0	FSCAL0[6:0]	13 (0x0D)	R/W	Frequency synthesizer calibration control. The value to use in this register is given by the SmartRF Studio software [4].

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26.2 Configuration Register Details - Registers that Loose Programming in SLEEP State

0x29: RESERVED

В	t Field Name	Reset	R/W	Description
7:	0	89 (0x59)	R/W	Use setting from SmartRF Studio [4]

0x2A: RESERVED

Bit	Field Name	Reset	R/W	Description
7:0		127 (0x7F)	R/W	Use setting from SmartRF Studio [4]

0x2B: RESERVED

	Bit	Field Name	Reset	R/W	Description
7	7:0		63 (0x3F)	R/W	Use setting from SmartRF Studio [4]

0x2C: TEST2 - Various Test Settings

Bit	Field Name	Reset	R/W	Description
7:0	TEST2[7:0]	136 (0x88)	R/W	Use setting from SmartRF Studio [4]
				This register will be forced to 0x88 or 0x81 when it wakes up from SLEEP mode, depending on the configuration of FIFOTHR.ADC_RETENTION. Note that the value read from this register when waking up from
				SLEEP always is the reset value (0x88) regardless of the ADC_RETENTION setting. The inverting of some of the bits due
				to the ADC_RETENTION setting is only seen INTERNALLY in the analog part.

0x2D: TEST1 - Various Test Settings

Bit	Field Name	Reset	R/W	Description
7:0	TEST1[7:0]	49 (0x31)	R/W	Use setting from SmartRF Studio [4]
				This register will be forced to 0x31 or 0x35 when it wakes up from SLEEP mode, depending on the configuration of FIFOTHR.ADC_RETENTION.
				Note that the value read from this register when waking up from SLEEP always is the reset value (0x31) regardless of the ADC_RETENTION setting. The inverting of some of the bits due to the ADC_RETENTION setting is only seen INTERNALLY in the analog part.

0x2E: TEST0 - Various Test Settings

Bit	Field Name	Reset	R/W	Description
7:2	TEST0[7:2]	2 (000010)	R/W	Use setting from SmartRF Studio [4]
1	VCO_SEL_CAL_EN	1	R/W	Enable VCO selection calibration stage when 1
0	TEST0[0]	1	R/W	Use setting from SmartRF Studio [4]

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26.3 Status Register Details

0x30 (0xF0): PARTNUM - Chip ID

	Bit	Field Name	Reset	R/W	Description
Ī	7:0	PARTNUM[7:0]	0 (0x00)	R	Chip part number

0x31 (0xF1): VERSION - Chip ID

Bit	Field Name	Reset	R/W	Description	
7:0	VERSION[7:0]	8 (0x08)	R	Chip version number.	

0x32 (0xF2): FREQEST - Frequency Offset Estimate from Demodulator

Bit	Field Name	Reset	R/W	Description
7:0	FREQOFF_EST		R	The estimated frequency offset (2"s complement) of the carrier. Resolution is $F_{XTAL}/2^{14}$ (1.59 - 1.65 kHz); range is ±202 kHz to ±210 kHz, depending on XTAL frequency. Frequency offset compensation is only supported for 2-FSK, GFSK, and 4-FSK modulation. This register will read 0 when using OOK modulation.

0x33 (0xF3): CRC_REG - CRC OK

Bit	Field Name	Reset	R/W	Description	
7	CRC OK		R	The last CRC comparison matched. Cleared when entering/restarting RX mode.	
6:0			R	Reserved	

0x34 (0xF4): RSSI - Received Signal Strength Indication

Bit	Field Name	Reset	R/W	Description	
7:0	RSSI		R	Received signal strength indicator	

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0x35 (0xF5): MARCSTATE - Main Radio Control State Machine State

Bit	Field Name	Reset	R/W	Description		
7:5			R0	Not used		
4:0	MARC_STATE[4:0]		R	Main Radio	Control FSM State	
				Value	State name	State (Figure 21, page 35)
				0 (0x00)	SLEEP	SLEEP
				1 (0x01)	IDLE	IDLE
				2 (0x02)	XOFF	XOFF
				3 (0x03)	VCOON_MC	MANCAL
				4 (0x04)	REGON_MC	MANCAL
				5 (0x05)	MANCAL	MANCAL
				6 (0x06)	VCOON	FS_WAKEUP
				7 (0x07)	REGON	FS_WAKEUP
				8 (0x08)	STARTCAL	CALIBRATE
				9 (0x09)	BWBOOST	SETTLING
				10 (0x0A)	FS_LOCK	SETTLING
				11 (0x0B)	IFADCON	SETTLING
				12 (0x0C)	ENDCAL	CALIBRATE
				13 (0x0D)	RX	RX
				14 (0x0E)	RX_END	RX
				15 (0x0F)	RX_RST	RX
				16 (0x10)	Reserved	
				17 (0x11)	RXFIFO_OVERFLOW	RXFIFO_OVERFLOW
				18 (0x12)	Reserved	
				- 22 (0x16)		
						k the SLEEP or XOFF state will make the chip enter the states.

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0x38 (0xF8): PKTSTATUS - Current GDOx Status and Packet Status

Bit	Field Name	Reset	R/W	Description	
7	CRC_OK		R	The last CRC comparison matched. Cleared when entering/restarting RX mode.	
6	CS		R	Carrier sense. Cleared when entering IDLE mode.	
5			R	Reserved	
4			R	Reserved	
3	SFD		R	Start of Frame Delimiter. This bit is asserted when sync word has been received and de-asserted at the end of the packet. It will also de-assert when a packet is discarded due to address or maximum length filtering or the radio enters RXFIFO_OVERFLOW state.	
2	GDO2		R	Current GDO2 value. Note: the reading gives the non-inverted value irrespective of what IOCFG2.GDO2_INV is programmed to.	
				It is not recommended to check for PLL lock by reading PKTSTATUS[2]	
1			R0	Not used	
0	GDO0		R	Current GDO0 value. Note: the reading gives the non-inverted value irrespective of what IOCFG0.GDO0_INV is programmed to. It is not recommended to check for PLL lock by reading PKTSTATUS[0] with GDO0_CFG=0x0A.	

0x3B (0xFB): RXBYTES - Overflow and Number of Bytes

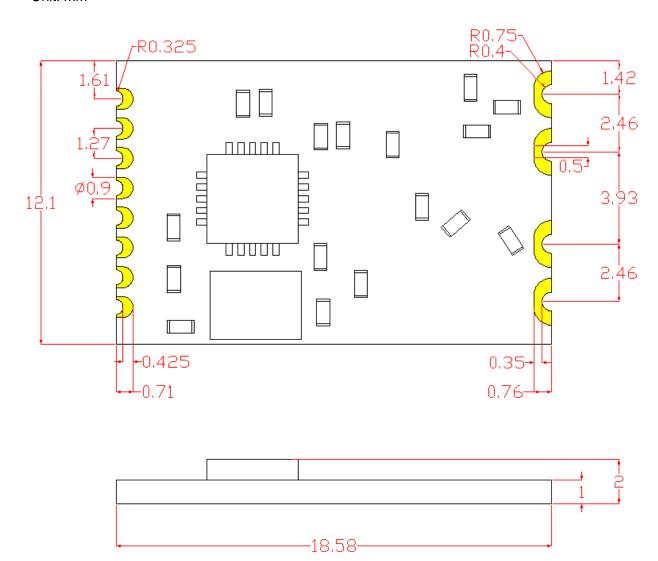
Bit	Field Name	Reset	R/W	Description
7	RXFIFO_OVERFLOW		R	
6:0	NUM_RXBYTES		R	Number of bytes in RX FIFO

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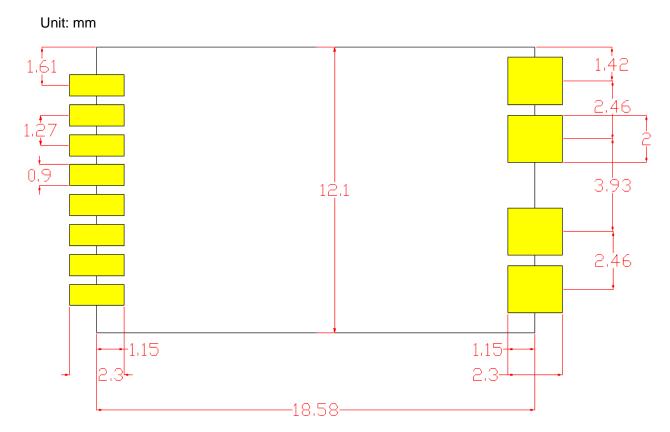
27 Module Package OutlineDrawing

Unit: mm



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28 Recommended PCB Land Pattern



29 Tray Packaging

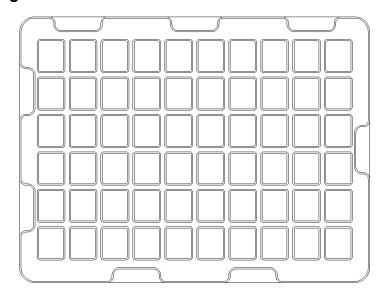


Figure 23. Package Outline Drawing

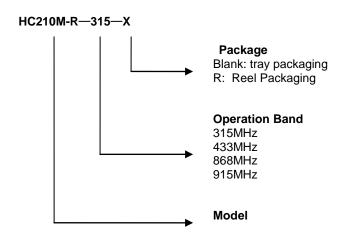
Note:

tray packaging, 60pcs/tray.



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30 Ordering Information:



31 Module Revisions:

Table 33 Revision History

Revisions	Date	Updated History		
Rev1.0	April 2015	The first final release		

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32 Contact us:

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